极低功耗、负电源轨输入、轨到轨输出、完全差分放大器

查询样品: THS4524-EP

特性

- 完全差分架构
- 带宽：**145MHz**
- 转换速率：**490V/μs**
- **HD_2：10kHz** 时为 **-133dBc (1 V_{RMS}，R_L=1kΩ)**
- **HD_3：10kHz** 时为 **-140dBc (1 V_{RMS}，R_L=1kΩ)**
- 输入电压噪声：**4.6nV/√Hz(f=100kHz)**
- 总谐波失真 **(THD)+N**：**1kHz** 时为 **-112dBc (0.00025%)**
  (22kHz BW，G=1，5 V_{PP})
- 开环路增益：**119dB**
- **NRI —** 负电源轨输入
- **RRO —** 轨到轨输出
- 输出共模控制（具有低偏移和漂移）
- 电源：
  - 电压：**2.5V (±1.25V)** 至 **5.5V (±2.75V)**
  - 电流：**1.14 mA/通道(ch)**
- 省电功能：**20μA**（典型值）

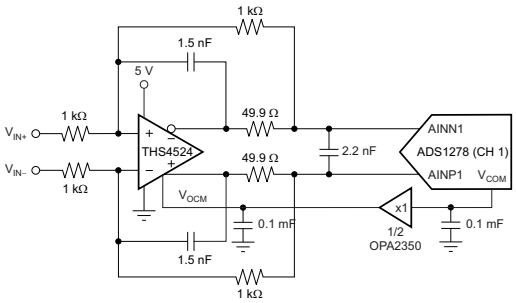
应用范围

- 低功耗逐次逼近 **(SAR)** 和三角积分 **(ΔΣ)** 模数转换器 **(ADC)** 驱动器
- 低功耗差分驱动器
- 低功耗差分信号调节
- 低功耗、高性能差分音频放大器

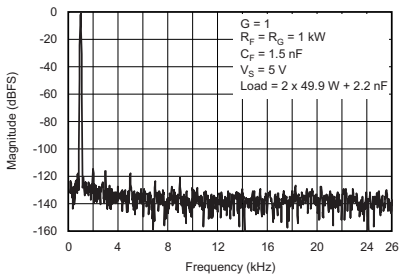
支持国防、航空航天、和医疗应用

- 受控基线
- 一个组装/测试场所
- 一个制造场所
- 军用温度范围 **(-55°C/125°C)** 内可用 (1)
- 延长的产品生命周期
- 延长的产品变更通知
- 产品可追溯性

THS4524 and ADS1278 Combined Performance



1-kHz FFT



Tone (Hz)	Signal (dBFS)	SNR (dBc)	THD (dBc)	SINAD (dBc)	SFDR (dBc)
1 k	−0.50	109.1	−107.9	105.5	113.7

(1) 可提供额外温度范围-请与厂家联系

说明

THS4524 是一款低功耗、完全差分运算放大器，此放大器带有轨到轨输出和一个包括负电源轨在内的输入共模范围。 这个放大器设计用于低功耗数据采集系统和高密度应用，在此类应用中功率耗散是一个关键参数，此放大器还在音频应用中提供出色的性能。

这个完全差分运算放大器特有精准的输出共模控制，此控制可在驱动模数转换器 (ADC) 时实现 dc 耦合。 与一个低于负电源轨和轨到轨输出的输入共模范围相耦合，这个控制可以很容易的实现与单端、地面基准信号源对接。 除此之外，THS4524 非常适合用于驱动逐次逼近寄存器 (SAR) 和只使用一个单 +2.5V 至 +5V 和地面电源的三角积分 (ΔΣ) ADC。

THS4524 完全差分运算放大器可在 –55°C 至 125°C 的完全工业温度范围内运行。

相关产品

器件	带宽 (BW) (MHz)	I_Q(mA)	100kHz 时的 THD (dBc)	V_N(nV/√Hz)	轨到轨
THS4520	570	15.3	-114	2	输出
THS4121	100	16	-79	5.4	输入/输出
THS4130	150	16	-107	1.3	否

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION(1)

T_A	PACKAGE-LEAD	PACKAGE DESIGNATOR		ORDERABLE PART NUMBER	TOP-SIDE MARKING	VID NUMBER
-55°C to 125°C	TSSOP - 38	DBT	Tape and reel, 2000	THS4524MDBTREP	THS4524EP	V62/12612-01XE
			Rails, 50	THS4524MDBTEP	THS4524EP	V62/12612-01XE-T

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or visit the device product folder at www.ti.com.

ABSOLUTE MAXIMUM RATINGS(1)

Over operating free-air temperature range (unless otherwise noted).

		THS4524	UNIT
Supply Voltage, $V_{S–}$ to V_{S+}		5.5	V
Input/Output Voltage, V_I ($V_{IN±}$, $V_{OUT±}$, V_{OCM} pins)		($V_{S–}$) – 0.7 to (V_{S+}) + 0.7V	V
Differential Input Voltage, V_{ID}		1	V
Output Current, I_O		100	mA
Input Current, I_I ($V_{IN±}$, V_{OCM} pins)		10	mA
Continuous Power Dissipation		See Thermal Characteristic Specifications	
Maximum Junction Temperature, T_J		+150	°C
Maximum Junction Temperature, T_J (continuous operation, long-term reliability)		+125	°C
Operating Free-air Temperature Range, T_A		–55 to 125	°C
Storage Temperature Range, T_{STG}		–65 to +150	°C
ESD Rating:	Human Body Model (HBM)	1300	V
	Charge Device Model (CDM)	1000	V
	Machine Model (MM)	50	V

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

THERMAL INFORMATION

THERMAL METRIC(1)		THS4524 DBT 38 PINS	UNITS
θ_{JA}	Junction-to-ambient thermal resistance(2)	106.9	°C/W
θ_{JCtop}	Junction-to-case (top) thermal resistance(3)	59.8	
θ_{JB}	Junction-to-board thermal resistance(4)	66.5	
ψ_{JT}	Junction-to-top characterization parameter(5)	17.1	
ψ_{JB}	Junction-to-board characterization parameter(6)	66.1	
θ_{JCbot}	Junction-to-case (bottom) thermal resistance(7)	N/A	

(1) 有关传统和全新热度量的更多信息，请参阅 *IC 封装热度量* 应用报告 （文献号：ZHCA543）。
(2) 在 JESD51-2a 描述的环境中，按照 JESD51-7 的规定，在一个 JEDEC 标准高 K 电路板上进行仿真，从而获得自然对流条件下的结至环境热阻抗。
(3) 通过在封装顶部模拟一个冷板测试来获得结至芯片外壳（顶部）的热阻。 不存在特定的 JEDEC 标准测试，但可在 ANSI SEMI 标准 G30-88 中找到内容接近的说明。
(4) 按照 JESD51-8 中的说明，通过在配有用于控制 PCB 温度的环形冷板夹具的环境中进行仿真，以获得结至电路板的热阻。
(5) 结至顶部的特征参数，(ψ_{JT})，估算真实系统中器件的结温，并使用 JESD51-2a（第 6 章和第 7 章）中描述的程序从仿真数据中提取出该参数以便获得 θ_{JA}。
(6) 结至电路板的特征参数，(ψ_{JB})，估算真实系统中器件的结温，并使用 JESD51-2a（第 6 章和第7 章）中描述的程序从仿真数据中提取出该参数以便获得 θ_{JA}。
(7) 通过在外露（电源）焊盘上进行冷板测试仿真来获得结至芯片外壳（底部）热阻。 不存在特定的 JEDEC 标准测试，但可在 ANSI SEMI 标准 G30-88 中找到了内容接近的说明。

ELECTRICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3$ V

At V_{S+} = +3.3 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

PARAMETER	CONDITIONS	T_A = -55°C to 125°C MIN	TYP	MAX	UNIT	TEST LEVEL(1)
AC PERFORMANCE						
Small-Signal Bandwidth	V_{OUT} = 100 mV_{PP}, G = 1		135		MHz	C
	V_{OUT} = 100 mV_{PP}, G = 2		49		MHz	C
	V_{OUT} = 100 mV_{PP}, G = 5		18.6		MHz	C
	V_{OUT} = 100 mV_{PP}, G = 10		9.3		MHz	C
Gain Bandwidth Product	V_{OUT} = 100 mV_{PP}, G = 10		93		MHz	C
Large-Signal Bandwidth	V_{OUT} = 2 V_{PP}, G = 1		95		MHz	C
Bandwidth for 0.1-dB Flatness	V_{OUT} = 2 V_{PP}, G = 1		20		MHz	C
Rising Slew Rate (Differential)	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		420		V/µs	C
Falling Slew Rate (Differential)	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		460		V/µs	C
Overshoot	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		1.2		%	C
Undershoot	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		2.1		%	C
Rise Time	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		4		ns	C
Fall Time	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		3.5		ns	C
Settling Time to 1%	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		13		ns	C
Harmonic Distortion						
2nd harmonic	f = 1 kHz, V_{OUT} = 1 V_{RMS}, G = 1(2), differential input		–122		dBc	C
	f = 1 MHz, V_{OUT} = 2 V_{PP}, G = 1		–85		dBc	C
3rd harmonic	f = 1 kHz, V_{OUT} = 1 V_{RMS}, G = 1(2), differential input		–141		dBc	C
	f = 1 MHz, V_{OUT} = 2 V_{PP}, G = 1		–90		dBc	C
Second-Order Intermodulation Distortion	Two-tone, f_1 = 2 MHz, f_2 = 2.2 MHz, V_{OUT} = 2-V_{PP} envelope		–83		dBc	C

(1) Test levels: **(A)** 100% tested. **(B)** Limits set by characterization and simulation. **(C)** Typical value only for information.
(2) Not directly measureable; calculated using noise gain of 101 as described in the Applications section, *Audio Performance*.

ELECTRICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3$ V (continued)

At V_{S+} = +3.3 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

PARAMETER	CONDITIONS	T_A = -55°C to 125°C			UNIT	TEST LEVEL(1)
		MIN	TYP	MAX		
Third-Order Intermodulation Distortion	Two-tone, f_1 = 2 MHz, f_2 = 2.2 MHz, V_{OUT} = 2-V_{PP} envelope		–90		dBc	C
Input Voltage Noise	f > 10 kHz		4.6		nV/√Hz	C
Input Current Noise	f > 100 kHz		0.6		pA/√Hz	C
Overdrive Recovery Time	Overdrive = ±0.5 V		80		ns	C
Output Balance Error	V_{OUT} = 100 mV, f ≤ 2 MHz (differential input)		–57		dB	C
Closed-Loop Output Impedance	f = 1 MHz (differential)		0.3		Ω	C
Channel-to-Channel Crosstalk	f = 10 kHz, measured differentially		–125		dB	C
DC PERFORMANCE						
Open-Loop Voltage Gain (A_{OL})		80	116		dB	A
Input-Referred Offset Voltage			±0.5	±7	mV	A
Input offset voltage drift(3)			±2		µV/°C	C
Input Bias Current			0.75	3.8	µA	A
Input bias current drift(3)			±1.75		nA/°C	C
Input Offset Current			±0.03	±2.0	uA	A
Input offset current drift(3)			±0.1		nA/°C	C

(3) Input Offset Voltage Drift, Input Bias Current Drift, and Input Offset Current Drift are average values calculated by taking data at –55°C and +125°C, computing the difference, and dividing by 180.

ELECTRICAL CHARACTERISTICS: $V_{S+} - V_{S-}$ = 3.3 V (continued)

At V_{S+} = +3.3 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

PARAMETER	CONDITIONS	T_A = -55°C to 125°C			UNIT	TEST LEVEL (1)
		MIN	TYP	MAX		
INPUT						
Common-Mode Input Voltage Low			-0.1	0	V	A
Common-Mode Input Voltage High		1.8	1.9		V	A
Common-Mode Rejection Ratio (CMRR)		73.8	100		dB	A
Input Resistance			110‖1.5		kΩ‖pF	C
OUTPUT						
Output Voltage Low			0.09	0.2	V	A
Output Voltage High		2.95	3.05		V	A
Output Current Drive (for linear operation)	R_L = 50 Ω		±35		mA	C
POWER SUPPLY						
Specified Operating Voltage		2.5		5.5	V	A
Quiescent Operating Current, per channel		0.85	1.0	1.25	mA	A
Power-Supply Rejection Ratio (±PSRR)		65	100		dB	A
POWER DOWN						
Enable Voltage Threshold	Assured *on* above 2.1 V		1.6	2.1	V	A
Disable Voltage Threshold	Assured *off* below 0.7 V	0.7	1.6		V	A
Disable Pin Bias Current			1		µA	C
Power Down Quiescent Current			10		µA	C
Turn-On Time Delay	Time to V_{OUT} = 90% of final value, V_{IN}= 2 V, R_L = 200 Ω		108		ns	C
Turn-Off Time Delay	Time to V_{OUT} = 10% of original value, V_{IN}= 2 V, R_L = 200 Ω		88		ns	C
V_{OCM} VOLTAGE CONTROL						
Small-Signal Bandwidth			23		MHz	C
Slew Rate			55		V/µs	C
Gain		0.98	0.99	1.021	V/V	A
Common-Mode Offset Voltage from V_{OCM} Input	Measured at V_{OUT} with V_{OCM} input driven, V_{OCM} = 1.65 V ±0.5 V		±2.5	±7	mV	A
Input Bias Current	V_{OCM} = 1.65 V ±0.5 V		±5	±8	µA	A
V_{OCM} Voltage Range			0.8 to 2.5		V	C
Input Impedance			72‖1.5		kΩ‖pF	C
Default Output Common-Mode Voltage Offset from (V_{S+} – V_{S-})/2	Measured at V_{OUT} with V_{OCM} input open		±1.5	±5	mV	A

ELECTRICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 5$ V

At V_{S+} = +5 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_F = 1 kΩ, R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, input and output referenced to midsupply, unless otherwise noted.

PARAMETER	CONDITIONS	T_A = -55°C to 125°C			UNIT	TEST LEVEL(1)
		MIN	TYP	MAX		
AC PERFORMANCE						
Small-Signal Bandwidth	V_{OUT} = 100 mV_{PP}, G = 1		145		MHz	C
	V_{OUT} = 100 mV_{PP}, G = 2		50		MHz	C
	V_{OUT} = 100 mV_{PP}, G = 5		20		MHz	C
	V_{OUT} = 100 mV_{PP}, G = 10		9.5		MHz	C
Gain Bandwidth Product	V_{OUT} = 100 mV_{PP}, G = 10		95		MHz	C
Large-Signal Bandwidth	V_{OUT} = 2 V_{PP}, G = 1		145		MHz	C
Bandwidth for 0.1-dB Flatness	V_{OUT} = 2 V_{PP}, G = 1		30		MHz	C
Rising Slew Rate (Differential)	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		490		V/µs	C
Falling Slew Rate (Differential)	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		600		V/µs	C
Overshoot	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		1		%	C
Undershoot	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		2.6		%	C
Rise Time	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		3.4		ns	C
Fall Time	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		3		ns	C
Settling Time to 1%	V_{OUT} = 2-V Step, G = 1, R_L = 200 Ω		10		ns	C
Harmonic Distortion						
2nd harmonic	f = 1 kHz, V_{OUT} = 1 V_{RMS}, G = 1(2), differential input		–122		dBc	C
	f = 1 MHz, V_{OUT} = 2 V_{PP}, G = 1		–85		dBc	C
3rd harmonic	f = 1 kHz, V_{OUT} = 1 V_{RMS}, G = 1(2), differential input		–141		dBc	C
	f = 1 MHz, V_{OUT} = 2 V_{PP}, G = 1		–91		dBc	C
Second-Order Intermodulation Distortion	Two-tone, f_1 = 2 MHz, f_2 = 2.2 MHz, V_{OUT} = 2-V_{PP} envelope		–86		dBc	C
Third-Order Intermodulation Distortion	Two-tone, f_1 = 2 MHz, f_2 = 2.2 MHz, V_{OUT} = 2-V_{PP} envelope		–93		dBc	C
Input Voltage Noise	f > 10 kHz		4.6		nV/√Hz	C
Input Current Noise	f > 100 kHz		0.6		pA/√Hz	C
SNR	V_{OUT} = 5 V_{PP}, 20 Hz to 22 kHz BW, differential input		114		dBc	C
THD+N	f = 1 kHz , V_{OUT} = 5 V_{PP}, 20 Hz to 22 kHz BW, differential input		112		dBc	C
Overdrive Recovery Time	Overdrive = ±0.5 V		75		ns	C
Output Balance Error	V_{OUT} = 100 mV, f < 2 MHz, V_{IN} differential		–57		dB	C
Closed-Loop Output Impedance	f = 1 MHz (differential)		0.3		Ω	C
Channel-to-Channel Crosstalk	f = 10 kHz, measured differentially		–125		dB	C
DC PERFORMANCE						
Open-Loop Voltage Gain (A_{OL})		83	119		dB	A
Input-Referred Offset Voltage			±0.5	±8	mV	A
Input offset voltage drift(3)			±2		µV/°C	C
Input Bias Current			0.9	5.5	µA	A
Input bias current drift(3)			±1.8		nA/°C	C

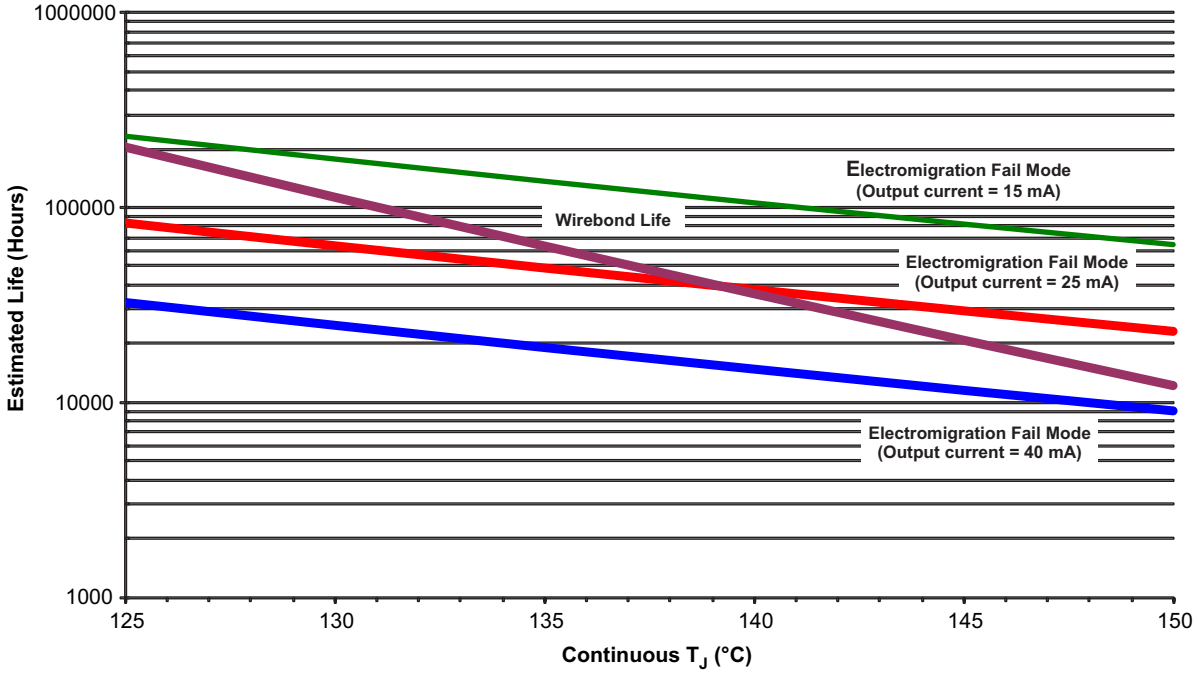
(1) Test levels: **(A)** 100% tested. **(B)** Limits set by characterization and simulation. **(C)** Typical value only for information.
(2) Not directly measureable; calculated using noise gain of 101 as described in the Applications section, *Audio Performance*.
(3) Input Offset Voltage Drift, Input Bias Current Drift, and Input Offset Current Drift are average values calculated by taking data at –55°C and +125°C, computing the difference, and dividing by 180.

ELECTRICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 5$ V (continued)

At V_{S+} = +5 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_F = 1 kΩ, R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, input and output referenced to midsupply, unless otherwise noted.

PARAMETER	CONDITIONS	T_A = -55°C to 125°C			UNIT	TEST LEVEL(1)
		MIN	TYP	MAX		
Input Offset Current			±0.03	±1.7	uA	A
Input offset current drift(4)			±0.1		nA/°C	C
INPUT						
Common-Mode Input Voltage Low			–0.1	0	V	A
Common-Mode Input Voltage High		3.5	3.6		V	A
Common-Mode Rejection Ratio (CMRR)		80	102		dB	A
Input Impedance			100‖0.7		kΩ‖pF	C
OUTPUT						
Output Voltage Low			0.115	0.2	V	A
Output Voltage High		4.65	4.7		V	A
Output Current Drive (for linear operation)	R_L = 50 Ω		±55		mA	C
POWER SUPPLY						
Specified Operating Voltage		2.5		5.5	V	A
Quiescent Operating Current, per channel		0.9	1.15	1.4	mA	A
Power-Supply Rejection Ratio (±PSRR)		62	100		dB	A
POWER DOWN						
Enable Voltage Threshold	Ensured *on* above 2.1 V		1.6	2.1	V	A
Disable Voltage Threshold	Ensured *off* below 0.7 V	0.7	1.6		V	A
Disable Pin Bias Current			1		µA	C
Power Down Quiescent Current			20		µA	C
Turn-On Time Delay	Time to V_{OUT} = 90% of final value, V_{IN}= 2 V, R_L = 200 Ω		70		ns	C
Turn-Off Time Delay	Time to V_{OUT} = 10% of original value, V_{IN}= 2 V, R_L = 200 Ω		60		ns	C
V_{OCM} VOLTAGE CONTROL						
Small-Signal Bandwidth			23		MHz	C
Slew Rate			55		V/µs	C
Gain		0.98	0.99	1.021	V/V	A
Common-Mode Offset Voltage from V_{OCM} Input	Measured at V_{OUT} with V_{OCM} input driven, V_{OCM} = 2.5V ±1 V		±5	±12.5	mV	A
Input Bias Current	V_{OCM} = 2.5V ±1 V		±20	±25	µA	A
V_{OCM} Voltage Range			0.8 to 4.2		V	C
Input Impedance			46‖1.5		kΩ‖pF	C
Default Output Common-Mode Voltage Offset from (V_{S+}– V_{S-})/2	Measured at V_{OUT} with V_{OCM} input open		±1	±8	mV	A

(4) Input Offset Voltage Drift, Input Bias Current Drift, and Input Offset Current Drift are average values calculated by taking data at –55°C and +125°C, computing the difference, and dividing by 180.



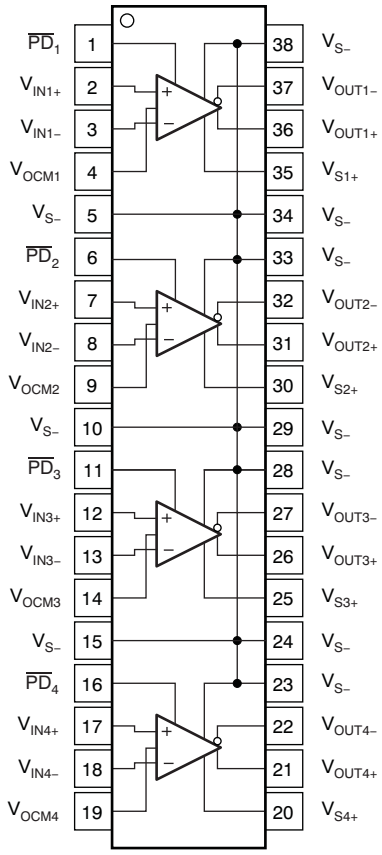
A. See datasheet for absolute maximum and minimum recommended operating conditions.

B. Silicon operating life design goal is 10 years at 105°C junction temperature (does not include package interconnect life).

Figure 1. Electromigration Fail Mode/Wirebond Life Derating Chart

DEVICE INFORMATION

TSSOP-38 (DBT PACKAGE)
(TOP VIEW)



TERMINAL FUNCTIONS

TSSOP-38		DESCRIPTION
PIN NO.	NAME	
1	$\overline{PD}_1$	Power down 1. $\overline{PD}$ = logic low puts channel into low-power mode. $\overline{PD}$ = logic high or open for normal operation.
2	V_{IN1+}	Noninverting amplifier 1 input
3	V_{IN1-}	Inverting amplifier 1 input
4	V_{OCM1}	Common-mode voltage input 1
5	V_{S-}	Negative power-supply input. Note that V_{S-} is tied together on multi-channel devices.
6	$\overline{PD}_2$	Power down 2. $\overline{PD}$ = logic low puts channel into low-power mode. $\overline{PD}$ = logic high or open for normal operation.
7	V_{IN2+}	Noninverting amplifier 2 input
8	V_{IN2-}	Inverting amplifier 2 input
9	V_{OCM2}	Common-mode voltage input 2
10	V_{S-}	Negative power-supply input. Note that V_{S-} is tied together on multi-channel devices.
11	$\overline{PD}_3$	Power down 3. $\overline{PD}$ = logic low puts channel into low-power mode. $\overline{PD}$ = logic high or open for normal operation.
12	V_{IN3+}	Noninverting amplifier 3 input
13	V_{IN3-}	Inverting amplifier 3 input
14	V_{OCM3}	Common-mode voltage input 3
15	V_{S-}	Negative power-supply input. Note that V_{S-} is tied together on multi-channel devices.
16	$\overline{PD}_4$	Power down 4. $\overline{PD}$ = logic low puts channel into low-power mode. $\overline{PD}$ = logic high or open for normal operation.
17	V_{IN4+}	Noninverting amplifier 4 input
18	V_{IN4-}	Inverting amplifier 4 input
19	V_{OCM4}	Common-mode voltage input 4
20	V_{S4+}	Amplifier 4 positive power-supply input
21	V_{OUT4+}	Noninverting amplifier 4 output
22	V_{OUT4-}	Inverting amplifier 4 output
23	V_{S-}	Negative power-supply input. Note that V_{S-} is tied together on multi-channel devices.
24	V_{S-}	Negative power-supply input. Note that V_{S-} is tied together on multi-channel devices.
25	V_{S3+}	Amplifier 3 positive power-supply input
26	V_{OUT3+}	Noninverting amplifier3 output
27	V_{OUT3-}	Inverting amplifier3 output
28	V_{S-}	Negative power-supply input. Note that V_{S-} is tied together on multi-channel devices.
29	V_{S-}	Negative power-supply input. Note that V_{S-} is tied together on multi-channel devices.
30	V_{S2+}	Amplifier 2 positive power-supply input
31	V_{OUT2+}	Noninverting amplifier 2 output
32	V_{OUT2-}	Inverting amplifier 2 output
33	V_{S-}	Negative power-supply input. Note that V_{S-} is tied together on multi-channel devices.
34	V_{S-}	Negative power-supply input. Note that V_{S-} is tied together on multi-channel devices.
35	V_{S1+}	Amplifier 1 positive power-supply input
36	V_{OUT1+}	Noninverting amplifier 1 output
37	V_{OUT1-}	Inverting amplifier 1 output
38	V_{S-}	Negative power-supply input. Note that V_{S-} is tied together on multi-channel devices.

TYPICAL CHARACTERISTICS

Table of Graphs: $V_{S+} - V_{S-} = 3.3$ V

TITLE	FIGURE
Small-Signal Frequency Response	Figure 2
Large-Signal Frequency Response	Figure 3
Large- and Small-Signal Pulse Response	Figure 4
Slew Rate vs V_{OUT} Step	Figure 5
Overdrive Recovery	Figure 6
10-kHz Output Spectrum on AP Analyzer	Figure 7
Harmonic Distortion vs Frequency	Figure 8
Harmonic Distortion vs Output Voltage at 1 MHz	Figure 9
Harmonic Distortion vs Gain at 1 MHz	Figure 10
Harmonic Distortion vs Load at 1 MHz	Figure 11
Harmonic Distortion vs V_{OCM} at 1 MHz	Figure 12
Two-Tone, Second- and Third-Order Intermodulation Distortion vs Frequency	Figure 13
Single-Ended Output Voltage Swing vs Load Resistance	Figure 14
Main Amplifier Differential Output Impedance vs Frequency	Figure 15
Frequency Response vs C_{LOAD} (R_{LOAD} = 1 kΩ)	Figure 16
R_O vs C_{LOAD} (R_{LOAD} = 1 kΩ)	Figure 17
Rejection Ratio vs Frequency	Figure 18
Crosstalk (Measured Differentially)	Figure 19
Turn-on Time	Figure 20
Turn-off Time	Figure 21
Input-Referred Voltage Noise and Current Noise Spectral Density	Figure 22
Main Amplifier Differential Open-Loop Gain and Phase	Figure 23
Output Balance Error vs Frequency	Figure 24
V_{OCM} Small-Signal Frequency Response	Figure 25
V_{OCM} Large-Signal Frequency Response	Figure 26
V_{OCM} Input Impedance vs Frequency	Figure 27

Table of Graphs: $V_{S+} - V_{S-} = 5$ V

TITLE	FIGURE
Small-Signal Frequency Response	Figure 28
Large-Signal Frequency Response	Figure 29
Large- and Small-Signal Pulse Response	Figure 30
Slew Rate vs V_{OUT} Step	Figure 31
Overdrive Recovery	Figure 32
10-kHz Output Spectrum on AP Analyzer	Figure 33
Harmonic Distortion vs Frequency	Figure 34
Harmonic Distortion vs Output Voltage at 1 MHz	Figure 35
Harmonic Distortion vs Gain at 1 MHz	Figure 36
Harmonic Distortion vs Load at 1 MHz	Figure 37
Harmonic Distortion vs V_{OCM} at 1 MHz	Figure 38
Two-Tone, Second- and Third-Order Intermodulation Distortion vs Frequency	Figure 39
Single-Ended Output Voltage Swing vs Load Resistance	Figure 40
Main Amplifier Differential Output Impedance vs Frequency	Figure 41
Frequency Response vs C_{LOAD} (R_{LOAD} = 1 kΩ)	Figure 42
R_O vs C_{LOAD} (R_{LOAD} = 1 kΩ)	Figure 43
Rejection Ratio vs Frequency	Figure 44
Crosstalk (Measured Differentially)	Figure 45
Turn-on Time	Figure 46
Turn-off Time	Figure 47
Input-Referred Voltage Noise and Current Noise Spectral Density	Figure 48
Main Amplifier Differential Open-Loop Gain and Phase	Figure 49
Output Balance Error vs Frequency	Figure 50
V_{OCM} Small-Signal Frequency Response	Figure 51
V_{OCM} Large-Signal Frequency Response	Figure 52
V_{OCM} Input Impedance vs Frequency	Figure 53

TYPICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3$ V

At V_{S+} = +3.3 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

SMALL-SIGNAL FREQUENCY RESPONSE

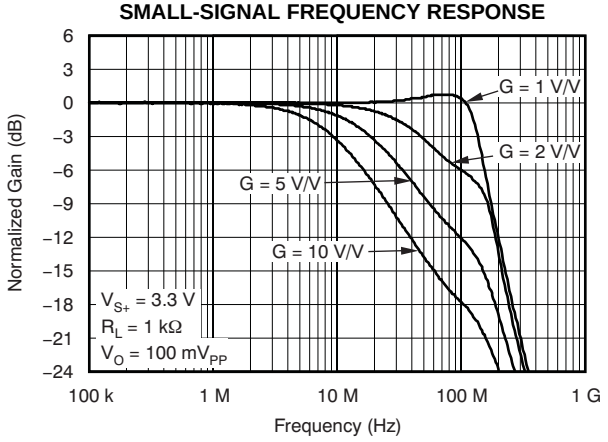


Figure 2.

LARGE-SIGNAL FREQUENCY RESPONSE

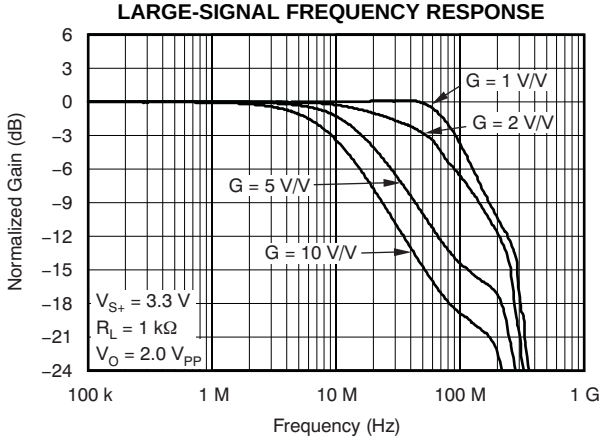


Figure 3.

LARGE- AND SMALL-SIGNAL PULSE RESPONSE

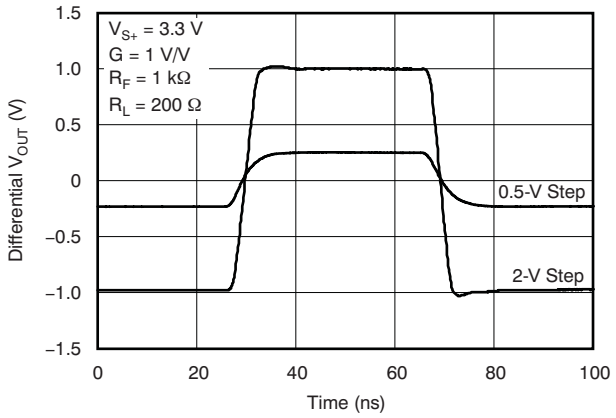


Figure 4.

SLEW RATE vs V_{OUT}

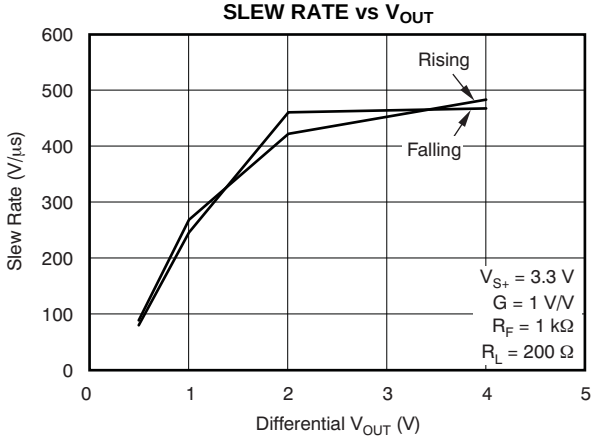


Figure 5.

OVERDRIVE RECOVERY

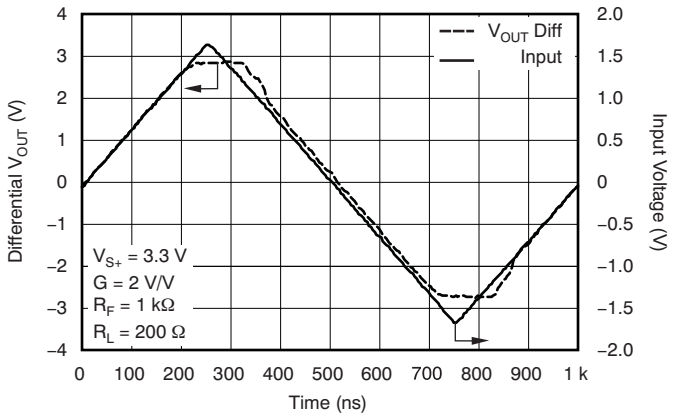


Figure 6.

10-kHz OUTPUT SPECTRUM ON AP ANALYZER

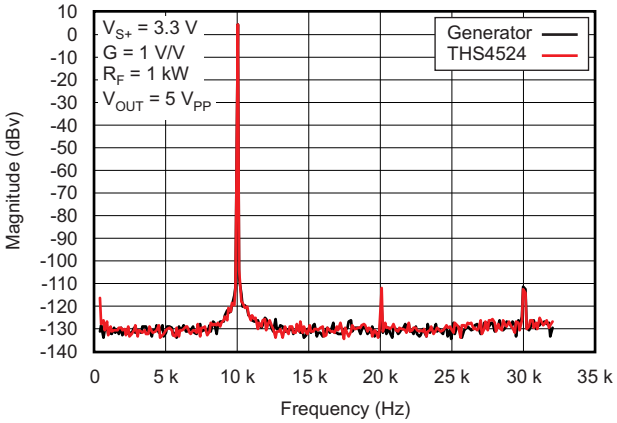


Figure 7.

TYPICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3$ V (continued)

At V_{S+} = +3.3 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

HARMONIC DISTORTION vs FREQUENCY

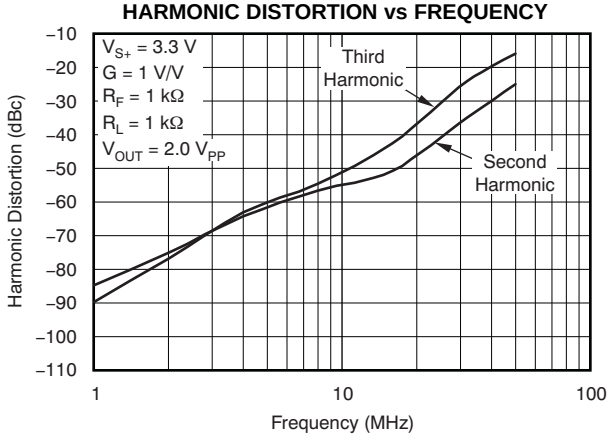


Figure 8.

HARMONIC DISTORTION vs V_{OUT} AT 1 MHZ

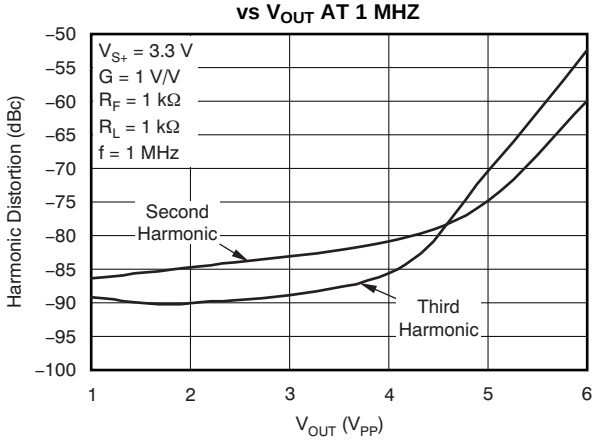


Figure 9.

HARMONIC DISTORTION vs GAIN AT 1 MHZ

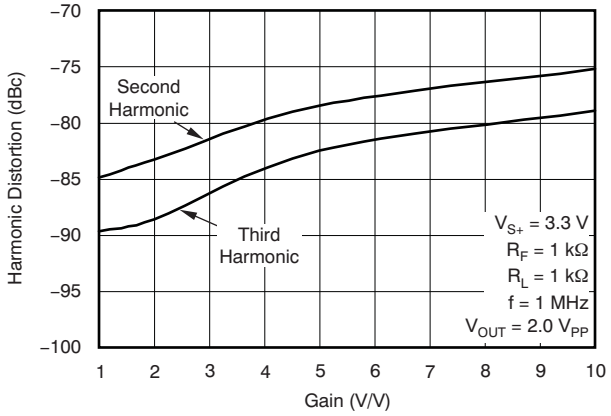


Figure 10.

HARMONIC DISTORTION vs LOAD AT 1 MHZ

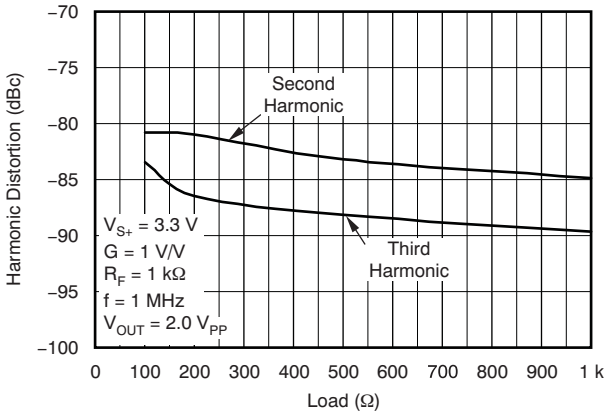


Figure 11.

HARMONIC DISTORTION vs V_{OCM} AT 1 MHZ

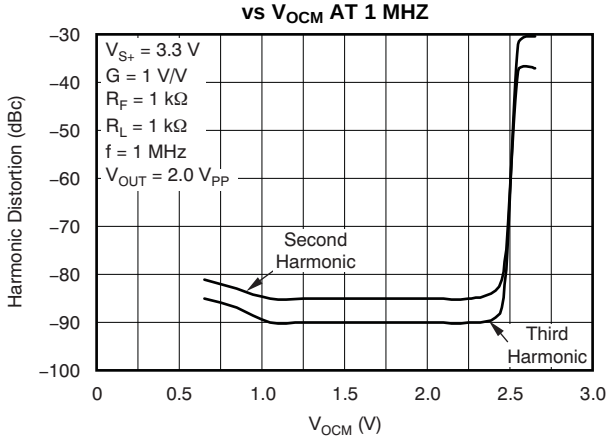


Figure 12.

TWO-TONE INTERMODULATION DISTORTION vs FREQUENCY

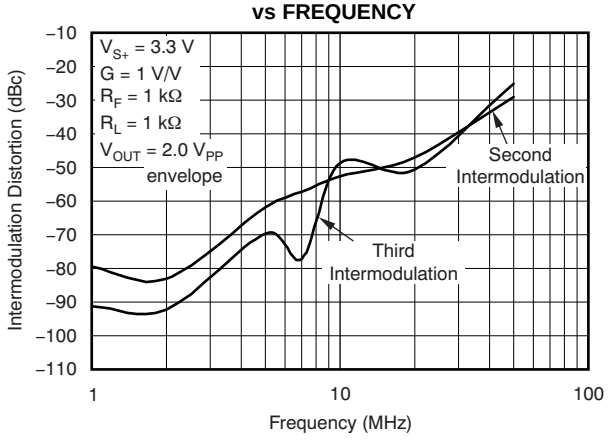


Figure 13.

TYPICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3$ V (continued)

At V_{S+} = +3.3 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

SINGLE-ENDED OUTPUT VOLTAGE SWING vs LOAD RESISTANCE

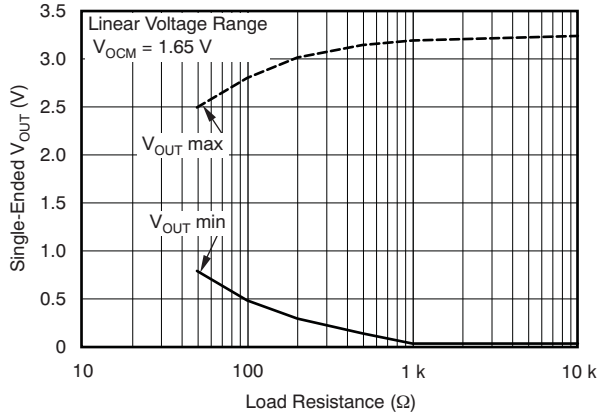


Figure 14.

MAIN AMPLIFIER DIFFERENTIAL OUTPUT IMPEDANCE vs FREQUENCY

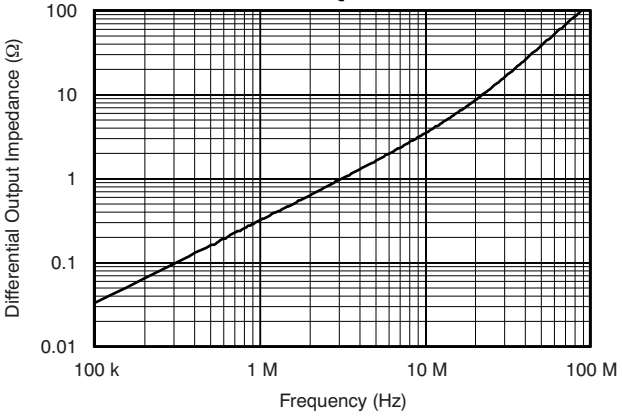


Figure 15.

FREQUENCY RESPONSE vs C_{LOAD} R_{LOAD} = 1 kΩ

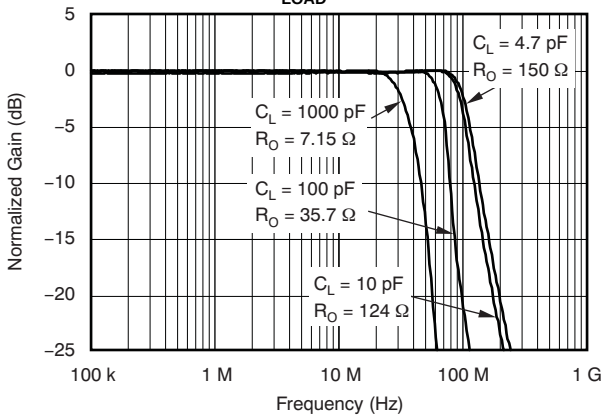


Figure 16.

R_O vs C_{LOAD} R_{LOAD} = 1 kΩ

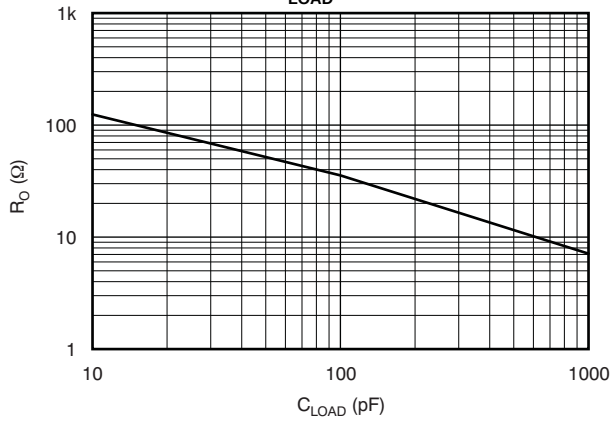


Figure 17.

REJECTION RATIO vs FREQUENCY

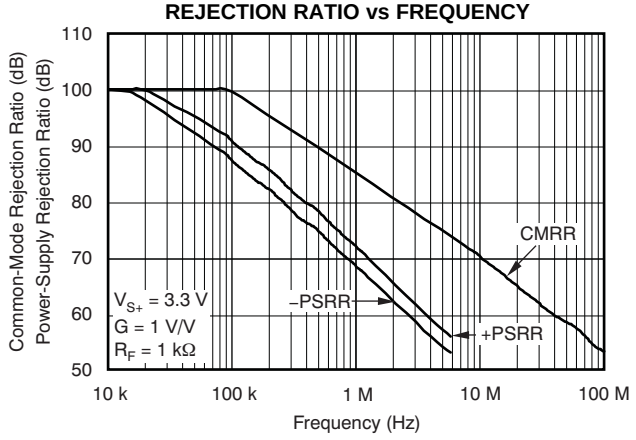


Figure 18.

CROSSTALK (MEASURED DIFFERENTIALLY)

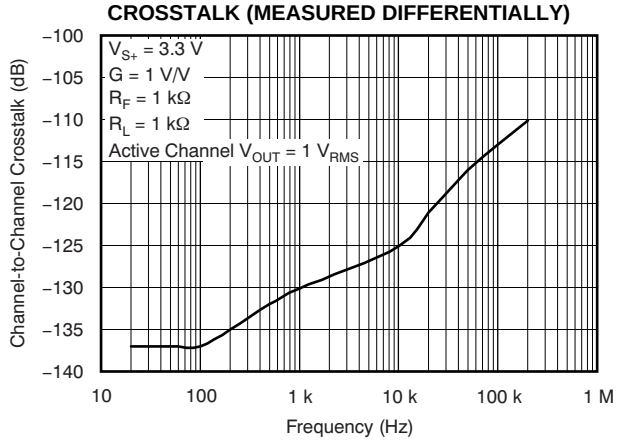


Figure 19.

TYPICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3$ V (continued)

At V_{S+} = +3.3 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

TURN-ON TIME

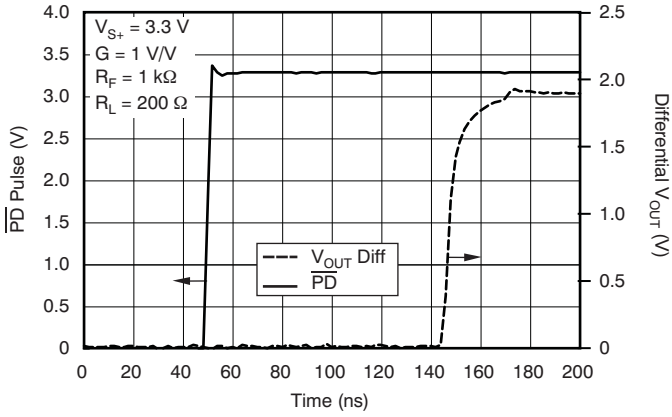


Figure 20.

TURN-OFF TIME

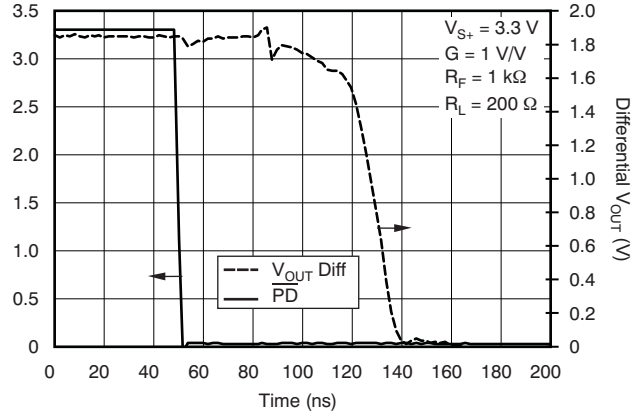


Figure 21.

INPUT-REFERRED VOLTAGE AND CURRENT NOISE SPECTRAL DENSITY

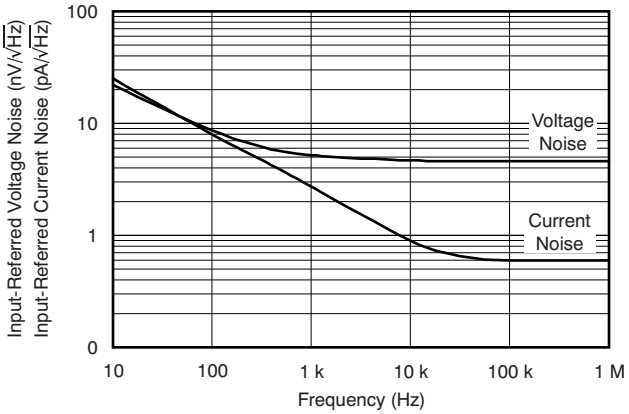


Figure 22.

MAIN AMPLIFIER DIFFERENTIAL OPEN-LOOP GAIN AND PHASE

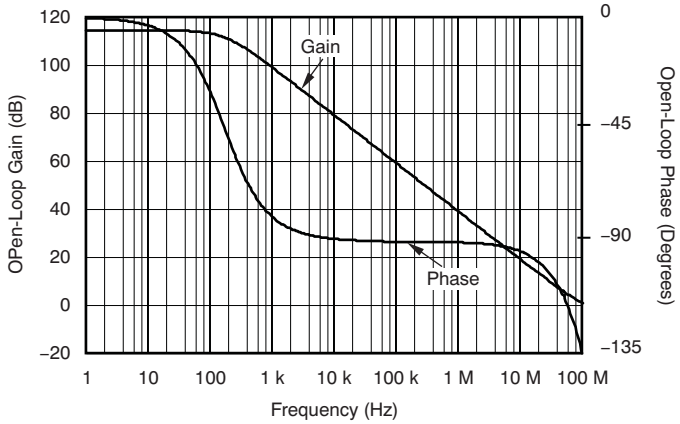


Figure 23.

OUTPUT BALANCE ERROR vs FREQUENCY

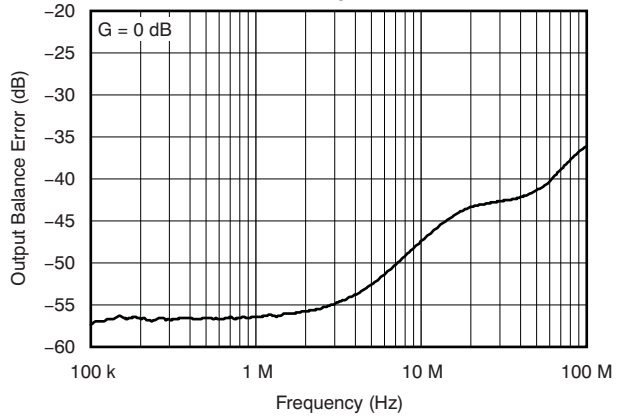


Figure 24.

V_{OCM} SMALL-SIGNAL FREQUENCY RESPONSE

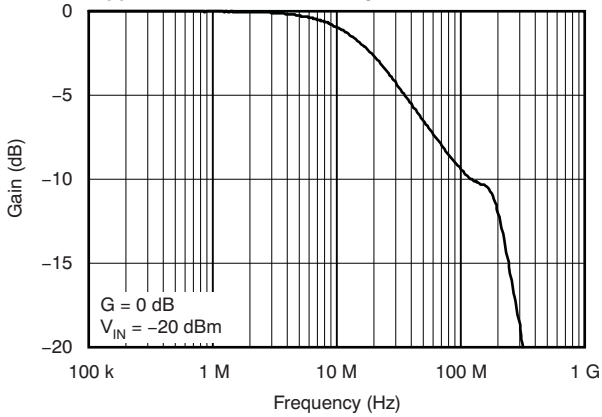


Figure 25.

TYPICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3$ V (continued)

At V_{S+} = +3.3 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

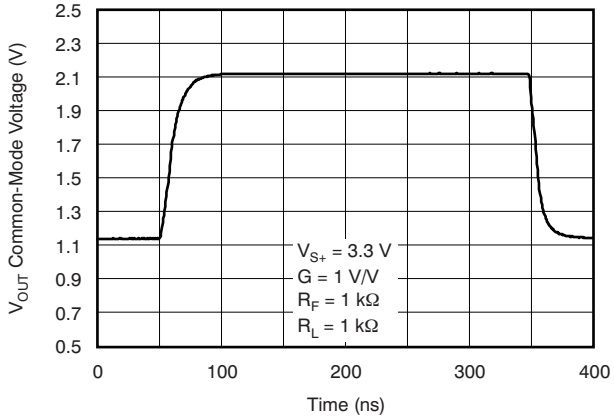


Figure 26.

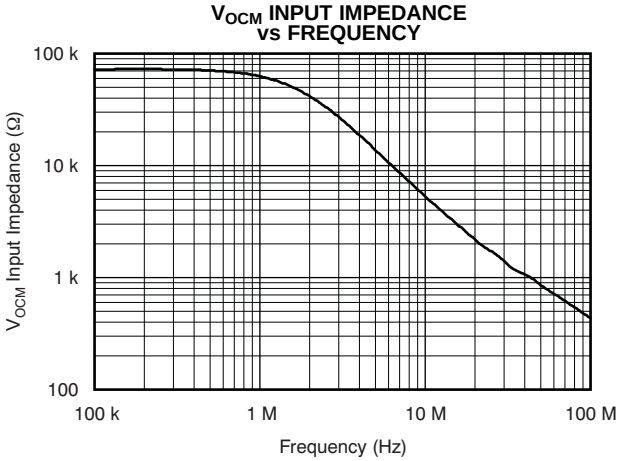


Figure 27.

TYPICAL CHARACTERISTICS: 5 V

At V_{S+} = +5 V, $V_{S–}$ = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_F = 1 kΩ, R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

SMALL-SIGNAL FREQUENCY RESPONSE

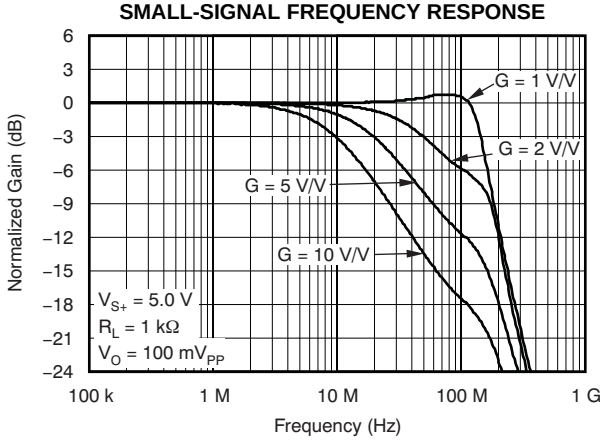


Figure 28.

LARGE-SIGNAL FREQUENCY RESPONSE

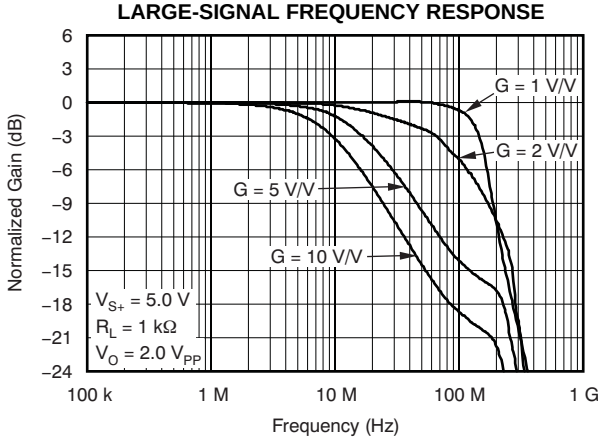


Figure 29.

LARGE- AND SMALL-SIGNAL PULSE RESPONSE

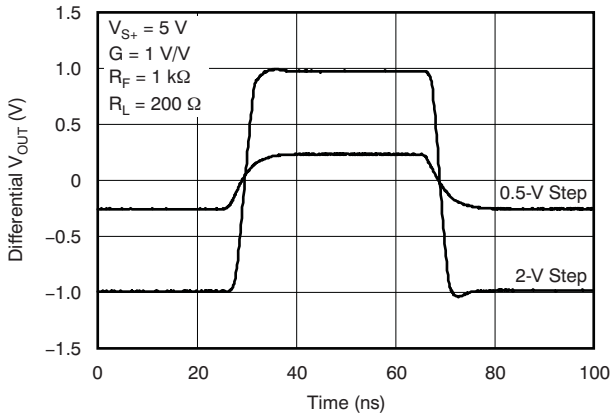


Figure 30.

SLEW RATE vs V_{OUT}

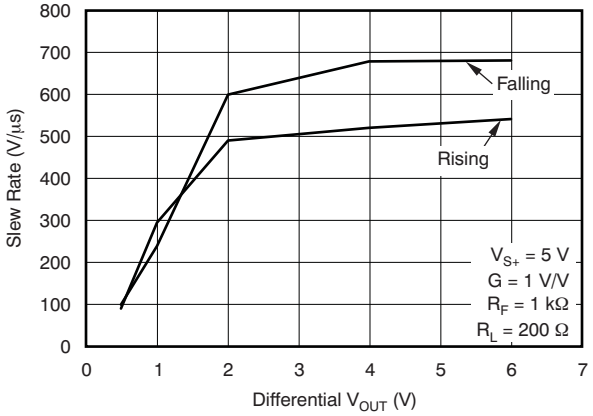


Figure 31.

OVERDRIVE RECOVERY

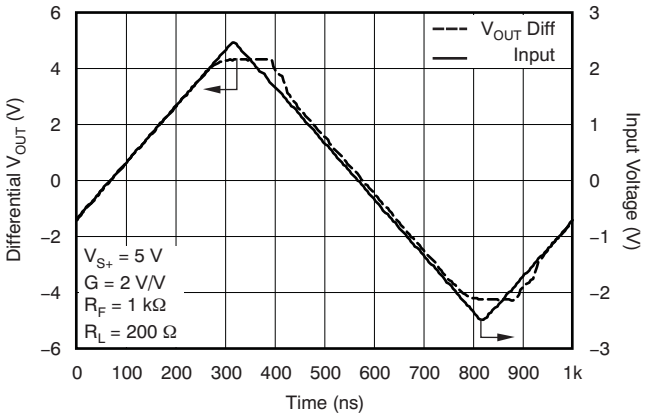


Figure 32.

10-kHz OUTPUT SPECTRUM ON AP ANALYZER AT V_{OUT} = 8 V_{PP}

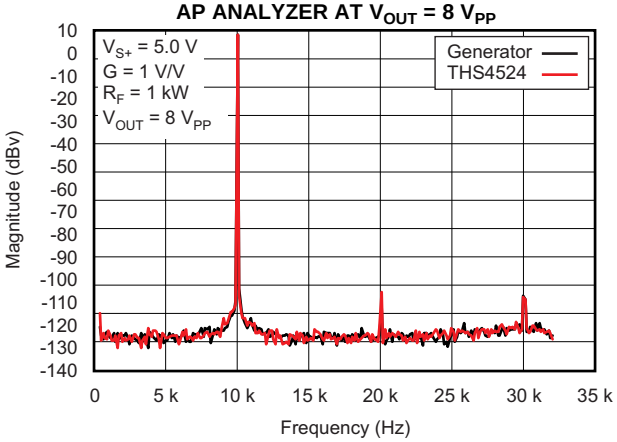


Figure 33.

TYPICAL CHARACTERISTICS: 5 V (continued)

At V_{S+} = +5 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_F = 1 kΩ, R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

HARMONIC DISTORTION vs FREQUENCY

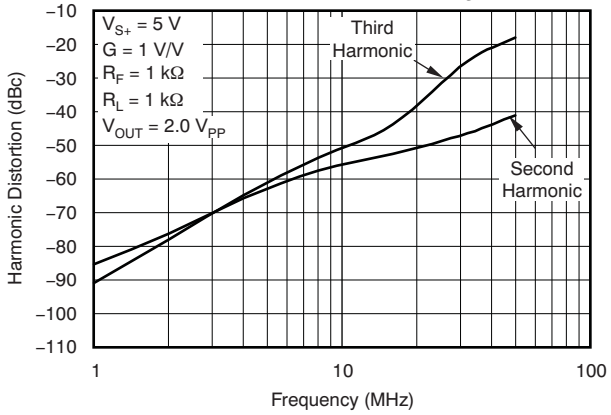


Figure 34.

HARMONIC DISTORTION vs V_{OUT} AT 1 MHZ

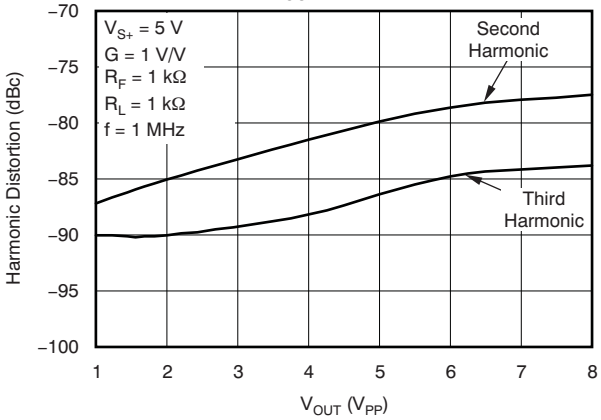


Figure 35.

HARMONIC DISTORTION vs GAIN AT 1 MHZ

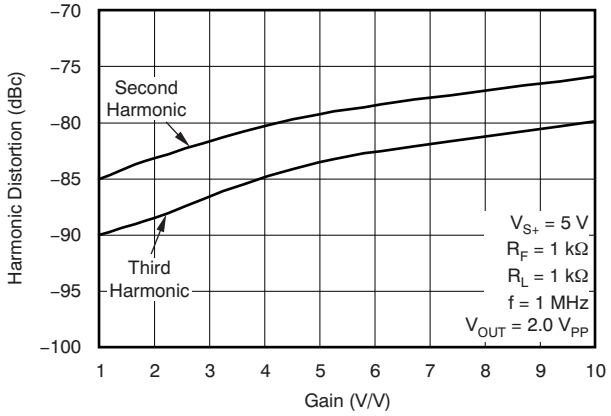


Figure 36.

HARMONIC DISTORTION vs LOAD AT 1 MHZ

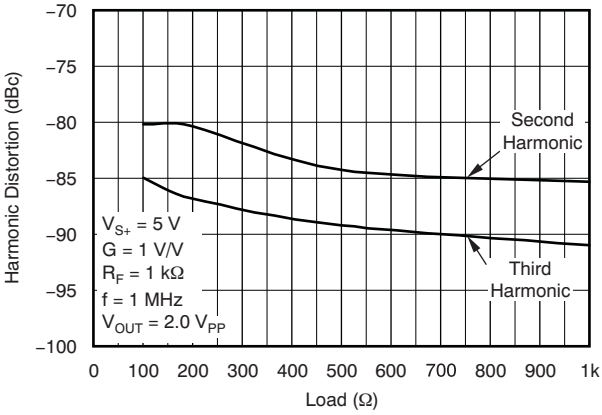


Figure 37.

HARMONIC DISTORTION vs V_{OCM} AT 1 MHZ

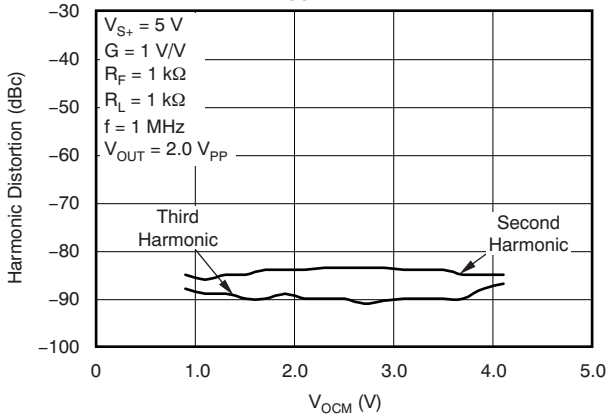


Figure 38.

TWO-TONE INTERMODULATION DISTORTION vs FREQUENCY

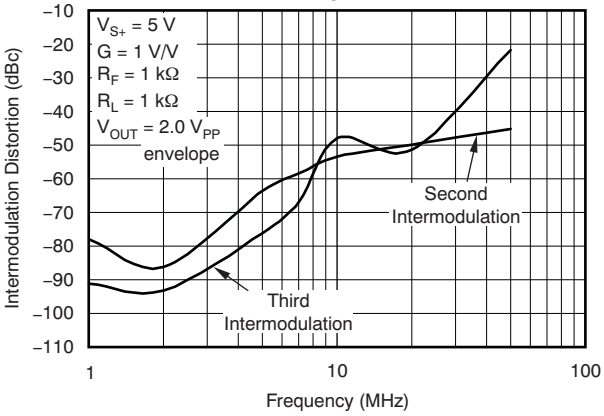


Figure 39.

TYPICAL CHARACTERISTICS: 5 V (continued)

At V_{S+} = +5 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_F = 1 kΩ, R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

SINGLE-ENDED OUTPUT VOLTAGE SWING vs DIFFERENTIAL LOAD RESISTANCE

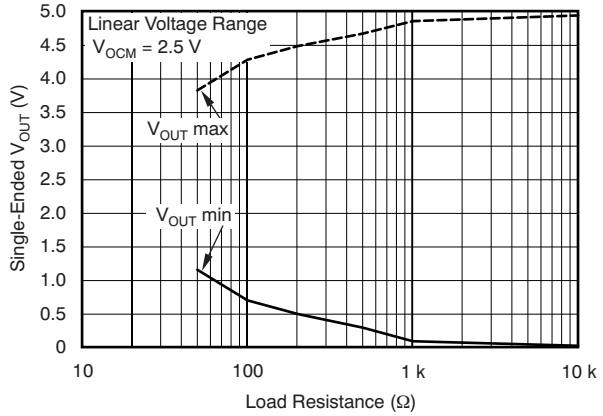


Figure 40.

MAIN AMPLIFIER DIFFERENTIAL OUTPUT IMPEDANCE vs FREQUENCY

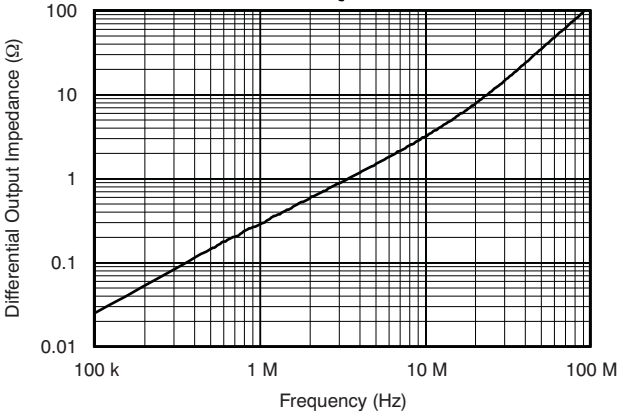


Figure 41.

FREQUENCY RESPONSE vs C_{LOAD} R_{LOAD} = 1 kΩ

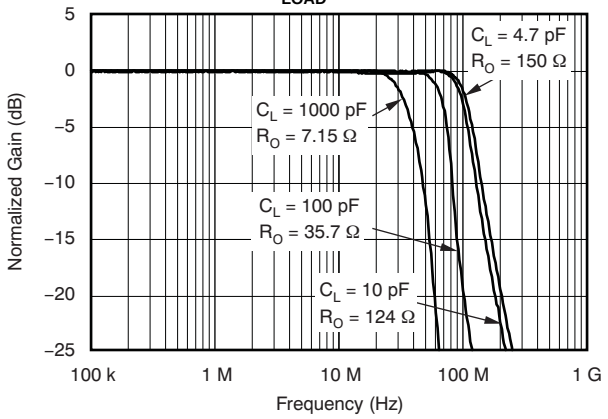


Figure 42.

R_O vs C_{LOAD} R_{LOAD} = 1 kΩ

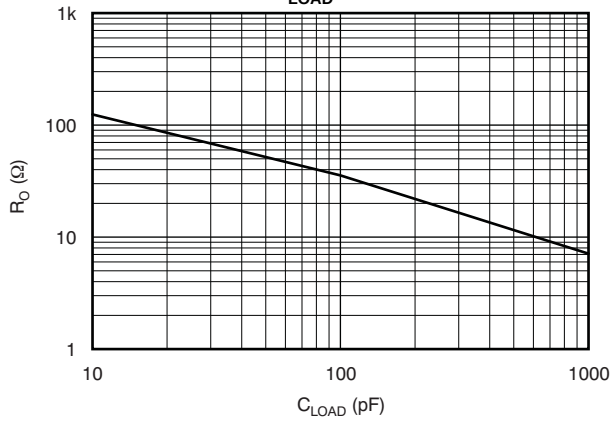


Figure 43.

REJECTION RATIO vs FREQUENCY

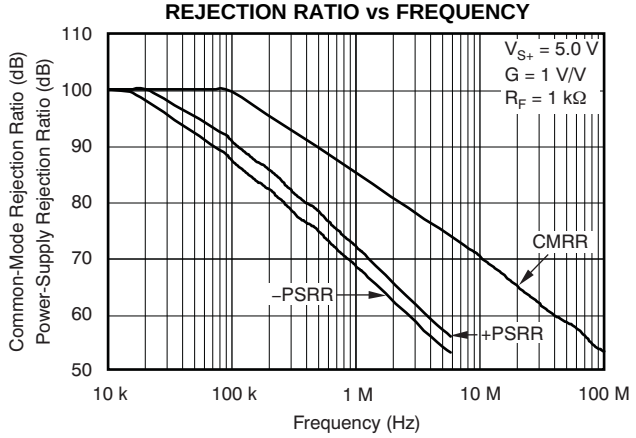


Figure 44.

CROSSTALK (MEASURED DIFFERENTIALLY)

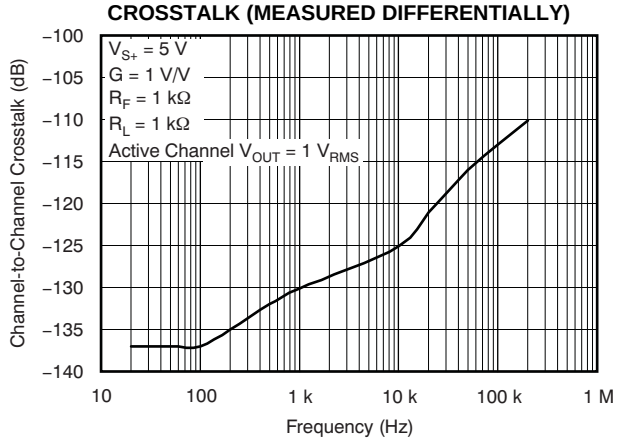


Figure 45.

TYPICAL CHARACTERISTICS: 5 V (continued)

At V_{S+} = +5 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_F = 1 kΩ, R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

TURN-ON TIME

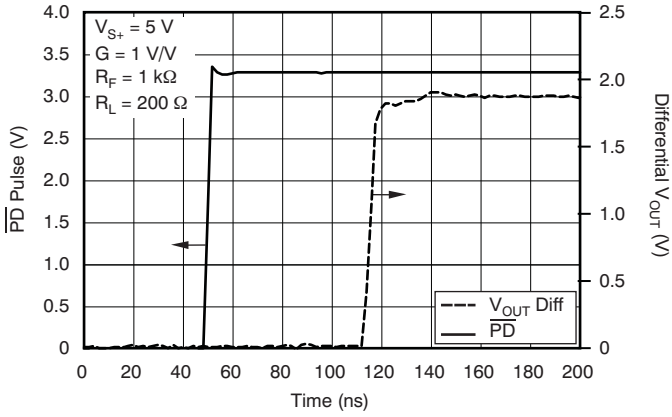


Figure 46.

TURN-OFF TIME

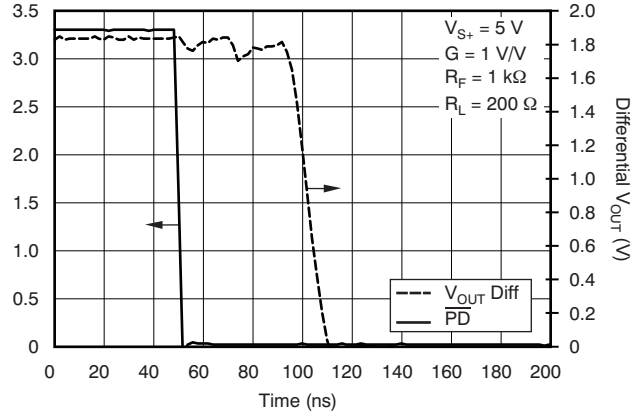


Figure 47.

INPUT-REFERRED VOLTAGE AND CURRENT NOISE SPECTRAL DENSITY

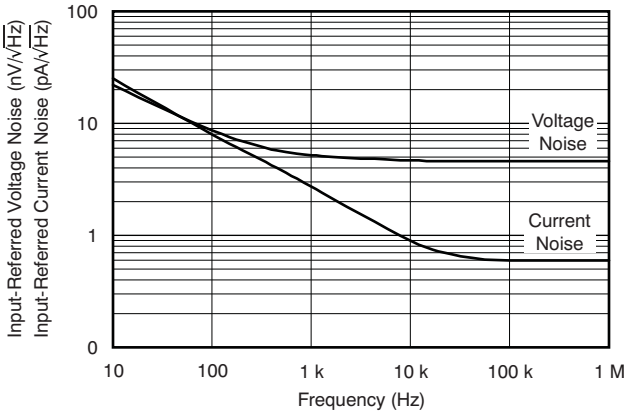


Figure 48.

MAIN AMPLIFIER DIFFERENTIAL OPEN-LOOP GAIN AND PHASE

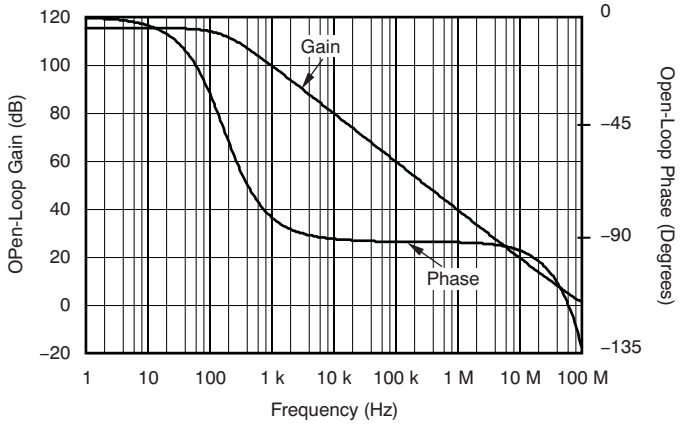


Figure 49.

OUTPUT BALANCE ERROR vs FREQUENCY

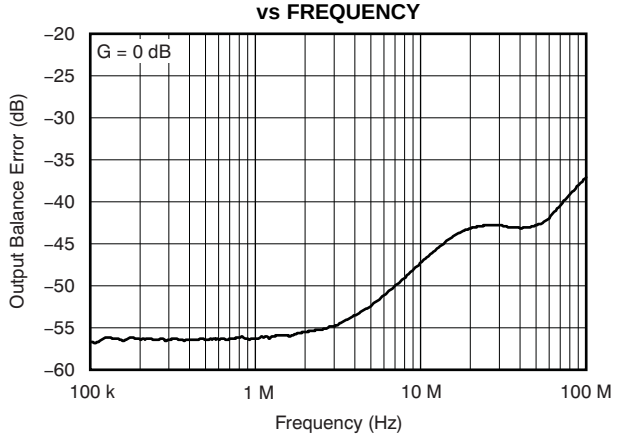


Figure 50.

V_{OCM} SMALL-SIGNAL FREQUENCY RESPONSE

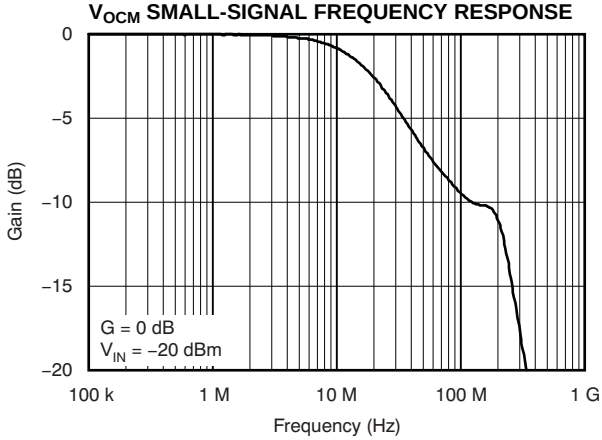


Figure 51.

TYPICAL CHARACTERISTICS: 5 V (continued)

At V_{S+} = +5 V, V_{S-} = 0 V, V_{OCM} = open, V_{OUT} = 2 V_{PP} (differential), R_F = 1 kΩ, R_L = 1 kΩ differential, G = 1 V/V, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

V_{OCM} LARGE-SIGNAL PULSE RESPONSE

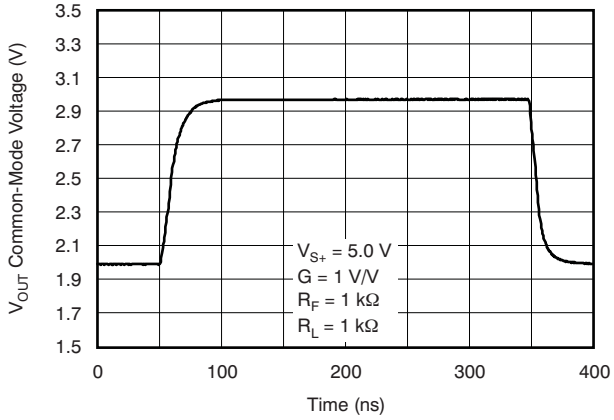


Figure 52.

V_{OCM} INPUT IMPEDANCE vs FREQUENCY

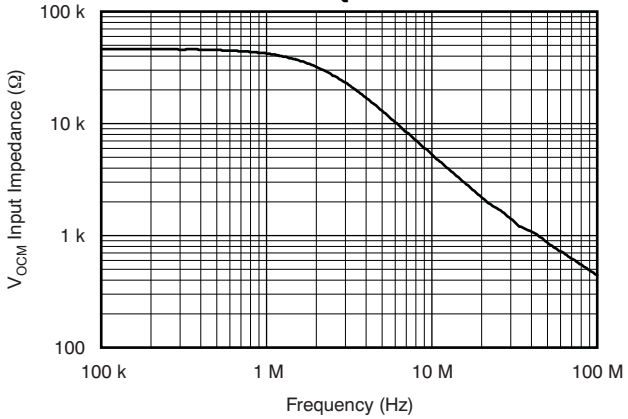


Figure 53.

TEST CIRCUITS

Overview

The THS4524 is tested with the test circuits shown in this section; all circuits are built using the available THS4524 evaluation module (EVM). For simplicity, power-supply decoupling is not shown; see the layout in the *Applications* section for recommendations. Depending on the test conditions, component values change in accordance with Table 1 and Table 2, or as otherwise noted. In some cases the signal generators used are ac-coupled and in others they dc-coupled 50-Ω sources. To balance the amplifier when ac-coupled, a 0.22-µF capacitor and 49.9-Ω resistor to ground are inserted across R_{IT} on the alternate input; when dc-coupled, only the 49.9-Ω resistor to ground is added across R_{IT}. A split power supply is used to ease the interface to common test equipment, but the amplifier can be operated in a single-supply configuration as described in the *Applications* section with no impact on performance. Also, for most of the tests, except as noted, the devices are tested with single-ended inputs and a transformer on the output to convert the differential output to single-ended because common lab test equipment has single-ended inputs and outputs. Similar or better performance can be expected with differential inputs and outputs.

As a result of the voltage divider on the output formed by the load component values, the amplifier output is attenuated. The ***Atten*** column in Table 2 shows the attenuation expected from the resistor divider. When using a transformer at the output (as shown in Figure 55), the signal sees slightly more loss because of transformer and line loss; these numbers are approximate.

Table 1. Gain Component Values for Single-Ended Input(1)

Gain	R_F	R_G	R_{IT}
1 V/V	1 kΩ	1 kΩ	52.3 Ω
2 V/V	1 kΩ	487 Ω	53.6 Ω
5 V/V	1 kΩ	187 Ω	59.0 Ω
10 V/V	1 kΩ	86.6 Ω	69.8 Ω

1. Gain setting includes 50-Ω source impedance. Components are chosen to achieve gain and 50-Ω input termination.

Table 2. Load Component Values For 1:1 Differential to Single-Ended Output Transformer(1)

R_L	R_O	R_{OT}	Atten
100 Ω	24.9 Ω	Open	6 dB
200 Ω	86.6 Ω	69.8 Ω	16.8 dB
499 Ω	237 Ω	56.2 Ω	25.5 dB
1 kΩ	487 Ω	52.3 Ω	31.8 dB

1. Total load includes 50-Ω termination by the test equipment. Components are chosen to achieve load and 50-Ω line termination through a 1:1 transformer.

Frequency Response

The circuit shown in Figure 54 is used to measure the frequency response of the circuit.

An HP network analyzer is used as the signal source and the measurement device. The output impedance of the HP network analyzer is is dc-coupled and is 50 Ω. R_{IT} and R_G are chosen to impedance-match to 50 Ω and maintain the proper gain. To balance the amplifier, a 49.9-Ω resistor to ground is inserted across R_{IT} on the alternate input.

The output is probed using a Tektronix high-impedance differential probe across the 953-Ω resistor and referred to the amplifier output by adding back the 0.42-dB because of the voltage divider on the output.

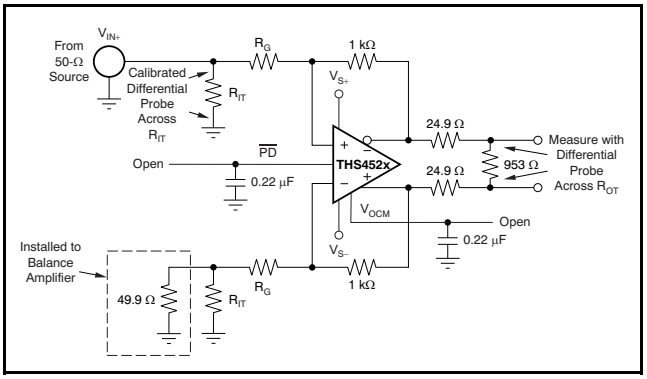


Figure 54. Frequency Response Test Circuit

Distortion

The circuit shown in Figure 55 is used to measure harmonic and intermodulation distortion of the amplifier.

An HP signal generator is used as the signal source and the output is measured with a Rhode and Schwarz spectrum analyzer. The output impedance of the HP signal generator is ac-coupled and is 50 Ω. R_{IT} and R_G are chosen to impedance match to 50 Ω and maintain the proper gain. To balance the amplifier, a 0.22-µF capacitor and 49.9-Ω resistor to ground are inserted across R_{IT} on the alternate input.

A low-pass filter is inserted in series with the input to reduce harmonics generated at the signal source. The level of the fundamental is measured and then a high-pass filter is inserted at the output to reduce the fundamental so it does not generate distortion in the input of the spectrum analyzer.

The transformer used in the output to convert the signal from differential to single-ended is an ADT1–1WT. It limits the frequency response of the circuit so that measurements cannot be made below approximately 1 MHz.

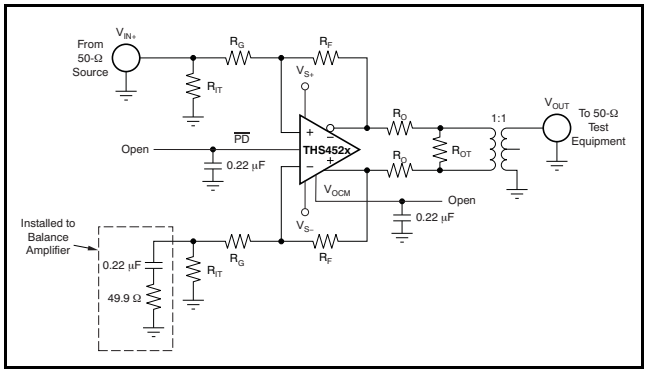


Figure 55. Distortion Test Circuit

Slew Rate, Transient Response, Settling Time, Output Impedance, Overdrive, Output Voltage, and Turn-On/Turn-Off Time

The circuit shown in Figure 56 is used to measure slew rate, transient response, settling time, output impedance, overdrive recovery, output voltage swing, and ampliifer turn-on/turn-off time. Turn-on and turn-off time are measured with the same circuit modified for 50-Ω input impedance on the $\overline{PD}$ input by replacing the 0.22-µF capacitor with a 49.9-Ω resistor. For output impedance, the signal is injected at V_{OUT} with V_{IN} open; the drop across the 2x 49.9-Ω resistors is then used to calculate the impedance seen looking into the amplifier output.

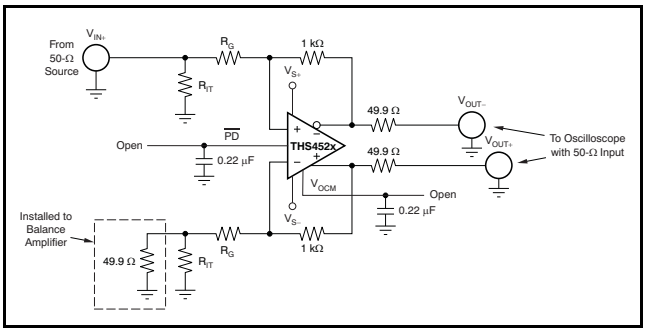


Figure 56. Slew Rate, Transient Response, Settling Time, Output Impedance, Overdrive Recovery, V_{OUT} Swing, and Turn-On/Turn-Off Test Circuit

Common-Mode and Power-Supply Rejection

The circuit shown in Figure 57 is used to measure the CMRR. The signal from the network analyzer is applied common-mode to the input. Figure 58 is used to measure the PSRR of V_{S+} and $V_{S–}$. The power supply under test is applied to the network analyzer dc offset input. For both CMRR and PSRR, the output is probed using a Tektronix high-impedance differential probe across the 953-Ω resistor and referred to the amplifier output by adding back the 0.42-dB as a result of the voltage divider on the output. For these tests, the resistors are matched for best results.

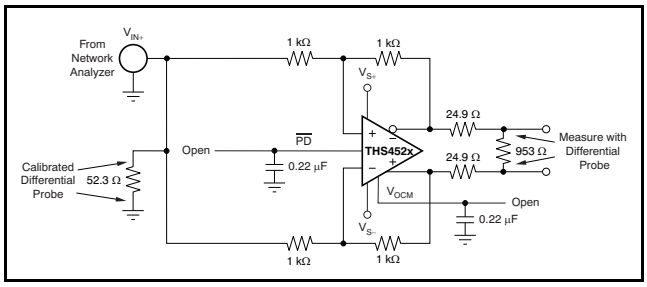


Figure 57. CMRR Test Circuit

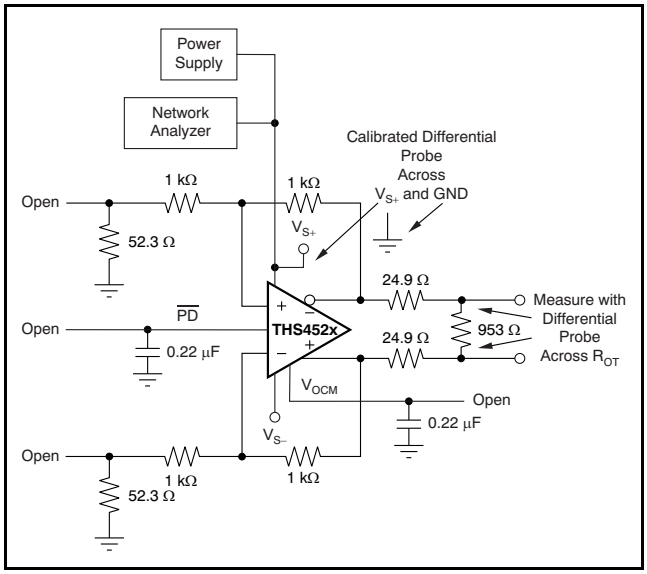


Figure 58. PSRR Test Circuit

V_{OCM} Input

The circuit illustrated in Figure 59 is used to measure the frequency response and input impedance of the V_{OCM} input. Frequency response is measured using a Tektronix high-impedance differential probe, with R_{CM} = 0 Ω at the common point of V_{OUT+} and $V_{OUT–}$, formed at the summing junction of the two matched 499-Ω resistors, with respect to ground. The input impedance is measured using a Tektronix high-impedance differential probe at the V_{OCM} input with R_{CM} = 10 kΩ and the drop across the 10-kΩ resistor is used to calculate the impedance seen looking into the amplifier V_{OCM} input.

The circuit shown in Figure 60 measures the transient response and slew rate of the V_{OCM} input. A 1-V step input is applied to the V_{OCM} input and the output is measured using a 50-Ω oscilloscope input referenced back to the amplifier output.

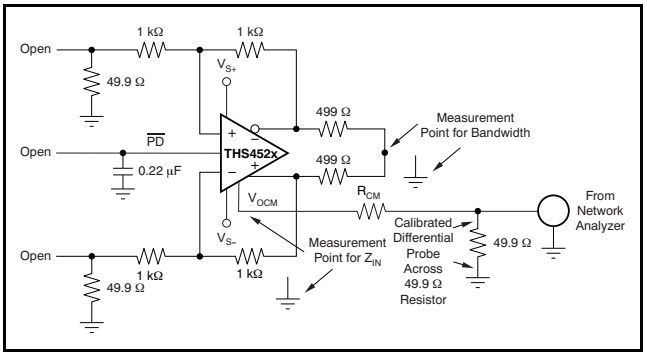


Figure 59. V_{OCM} Input Test Circuit

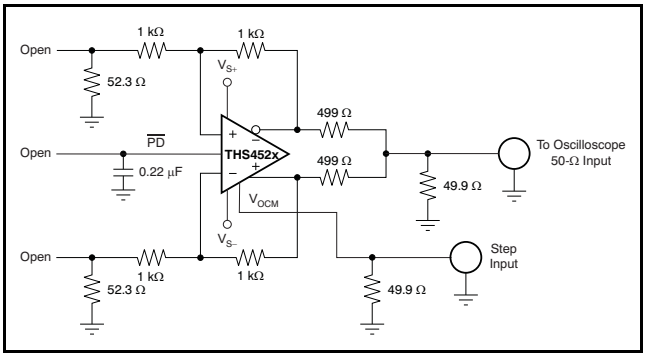


Figure 60. V_{OCM} Transient Response and Slew Rate Test Circuit

APPLICATION INFORMATION

The following circuits show application information for the THS4524. For simplicity, power-supply decoupling capacitors are not shown in these diagrams; see the *EVM and Layout Recommendations* section for suggested guidelines. For more details on the use and operation of fully differential op amps, refer to the Application Report *Fully-Differential Amplifiers* (SLOA054), available for download from the TI web site at www.ti.com.

Differential Input to Differential Output Amplifier

The THS4524 is a fully-differential operational amplifier that can be used to amplify differential input signals to differential output signals. Figure 61 shows a basic block diagram of the circuit (V_{OCM} and $\overline{PD}$ inputs not shown). The gain of the circuit is set by R_F divided by R_G.

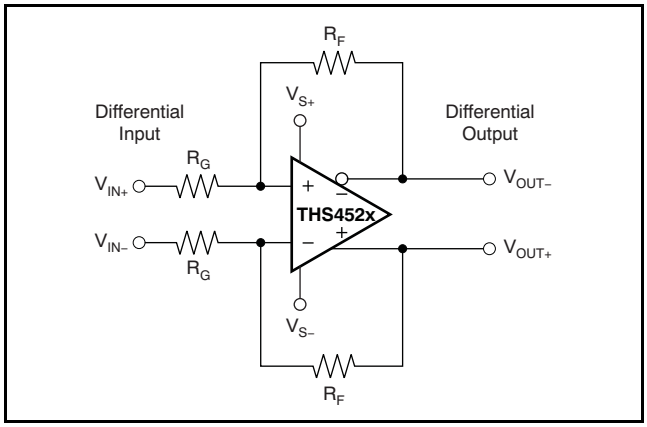


Figure 61. Differential Input to Differential Output Amplifier

Single-Ended Input to Differential Output Amplifier

The THS4524 can also amplify and convert single-ended input signals to differential output signals. Figure 62 illustrates a basic block diagram of the circuit (V_{OCM} and $\overline{PD}$ inputs not shown). The gain of the circuit is again set by R_F divided by R_G.

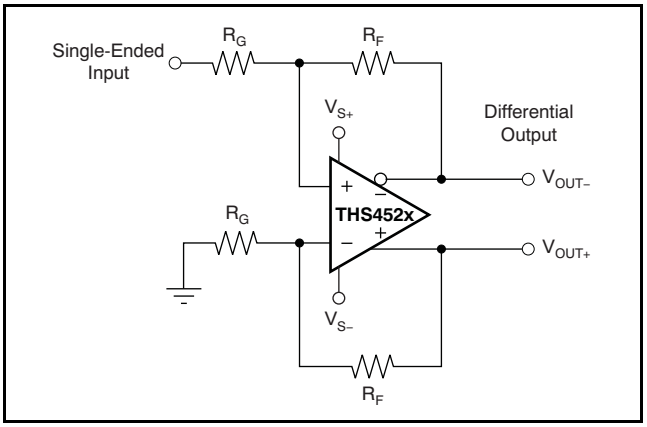


Figure 62. Single-Ended Input to Differential Output Amplifier

Input Common-Mode Voltage Range

The input common-mode voltage of a fully-differential op amp is the voltage at the **+** and **–** input pins of the device.

It is important to not violate the input common-mode voltage range (V_{ICR}) of the op amp. Assuming the op amp is in linear operation, the voltage across the input pins is only a few millivolts at most. Therefore, finding the voltage at one input pin determines the input common-mode voltage of the op amp.

Treating the negative input as a summing node, the voltage is given by Equation 1:

$$\left(V_{OUT+} \times \frac{R_G}{R_G + R_F}\right) + \left(V_{IN-} \times \frac{R_F}{R_G + R_F}\right) \quad (1)$$

To determine the V_{ICR} of the op amp, the voltage at the negative input is evaluated at the extremes of V_{OUT+}. As the gain of the op amp increases, the input common-mode voltage becomes closer and closer to the input common-mode voltage of the source.

Setting the Output Common-Mode Voltage

The output common-model voltage is set by the voltage at the V_{OCM} pin. The internal common-mode control circuit maintains the output common-mode voltage within 5-mV offset (typ) from the set voltage. If left unconnected, the common-mode set point is set to midsupply by internal circuitry, which may be overdriven from an external source.

Figure 63 represents the V_{OCM} input. The internal V_{OCM} circuit has typically 23 MHz of –3 dB bandwidth, which is required for best performance, but it is intended to be a dc bias input pin. A 0.22-µF bypass capacitor is recommended on this pin to reduce noise. The external current required to overdrive the internal resistor divider is given approximately by the formula in Equation 2:

$$I_{EXT} = \frac{2V_{OCM} - (V_{S+} - V_{S-})}{50\ k\Omega} \quad (2)$$

where:

- V_{OCM} is the voltage applied to the V_{OCM} pin

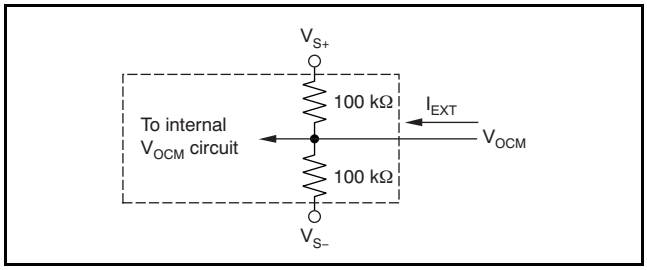


Figure 63. V_{OCM} Input Circuit

Typical Performance Variation with Supply Voltage

The THS4524 provides excellent performance across the specified power-supply range of 2.5 V to 5.5 V with only minor variations. The input and output voltage compliance ranges track with the power supply in nearly a 1:1 correlation. Other changes can be observed in slew rate, output current drive, open-loop gain, bandwidth, and distortion. Table 3 shows the typical variation to be expected in these key performance parameters.

Single-Supply Operation

To facilitate testing with common lab equipment, the THS4524EVM allows for split-supply operation; most of the characterization data presented in this data sheet is measured using split-supply power inputs. The device can easily be used with a single-supply power input without degrading performance.

Figure 64 shows a dc-coupled single-supply circuit with single-ended inputs. This circuit can also be applied to differential input sources.

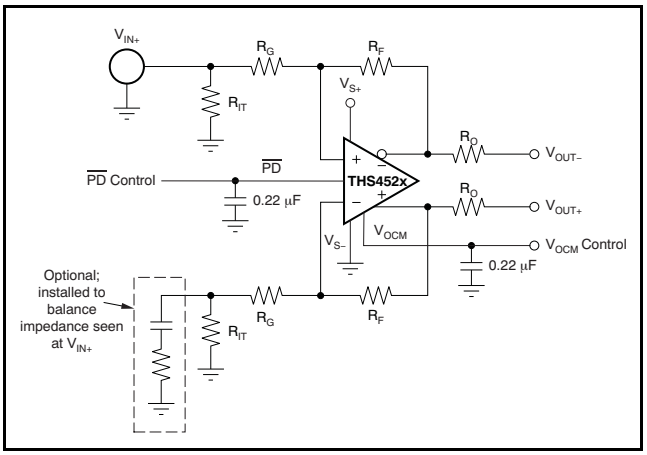


Figure 64. THS4524 DC-Coupled Single-Supply with Single-Ended Inputs

The input common-mode voltage range of the THS4524 is designed to include the negative supply voltage. in the circuit shown in Figure 64, the signal source is referenced to ground. V_{OCM} is set by an external control source or, if left unconnected, the internal circuit defaults to midsupply. Together with the input impedance of the amplifier circuit, R_{IT} provides input termination, which is also referenced to ground.

Note that R_{IT} and optional matching components are added to the alternate input to balance the impedance at signal input.

Table 3. Typical Performance Variation versus Power-Supply Voltage

PARAMETER	V_S = 5 V	V_S = 3.3 V	V_S = 2.5 V
–3-dB Small-signal bandwidth	145 MHz	135 MHz	125 MHz
Slew rate (2-V step)	490 V/µs	420 V/µs	210 V/µs
Harmonic distortion at 1 MHz, 2 V_{PP}, R_L = 1 kΩ			
Second harmonic	–85 dBc	–85 dBc	–84 dBc
Third harmonic	–91 dBc	–90 dBc	–88 dBc
Open-loop gain	119 dB	116 dB	115 dB
Linear output current drive	55 mA	35 mA	24 mA

Low-Power Applications and the Effects of Resistor Values on Bandwidth

For low-power operation, it may be necessary to increase the gain setting resistors values to limit current consumption and not load the source. Using larger value resistors lowers the bandwidth of the THS4524 as a result of the interactions between the resistors, the device parasitic capacitance, and printed circuit board (PCB) parasitic capacitance. Figure 65 shows the small-signal frequency response with 1-kΩ, 10-kΩ, and 100-kΩ resistors for R_F, R_G, and R_L (impedance is assumed to typically increase for all three resistors in low-power applications).

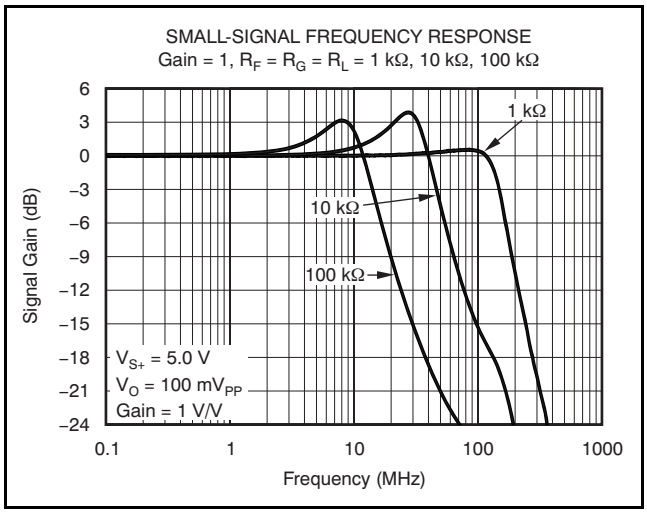


Figure 65. THS4524 Frequency Response with Various Gain Setting and Load Resistor Values

Frequency Response Variation due to Package Options

Users can see variations in the small-signal (V_{OUT} = 100 mV_{PP}) frequency response between the available package options for the THS452x family as a result of parasitic elements associated with each package and board layout changes. Figure 66 shows the variance measured in the lab; this variance is to be expected even when using a good layout.

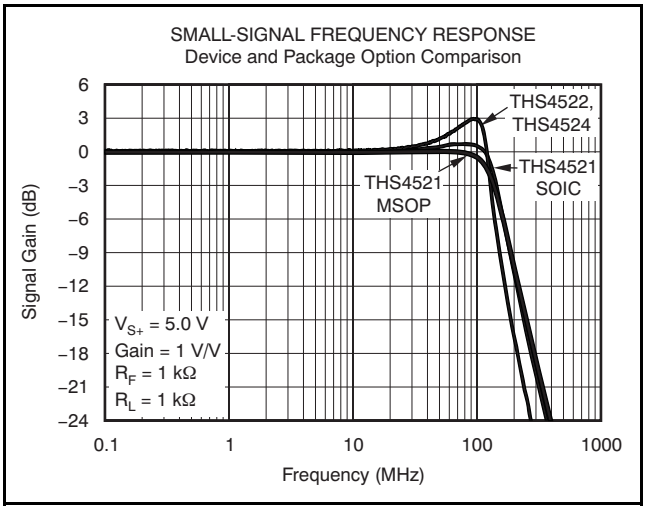


Figure 66. Small-Signal Frequency Response: Package Variations

Driving Capacitive Loads

The THS4524 is designed for a nominal capacitive load of 1 pF on each output to ground. When driving capacitive loads greater than 1 pF, it is recommended to use small resistors (R_O) in series with the output, placed as close to the device as possible. Without R_O, capacitance on the output interacts with the output impedance of the amplifier and causes phase shift in the loop gain of the amplifier that reduces the phase margin. This reduction in phase margin results in frequency response peaking; overshoot, undershoot, and/or ringing when a step or square-wave signal is applied; and may lead to instability or oscillation. Inserting R_O isolates the phase shift from the loop gain path and restores the phase margin, but it also limits bandwidth. Figure 67 shows the recommended values of R_O versus capacitive loads (C_L), and Figure 68 shows an illustration of the frequency response with various values.

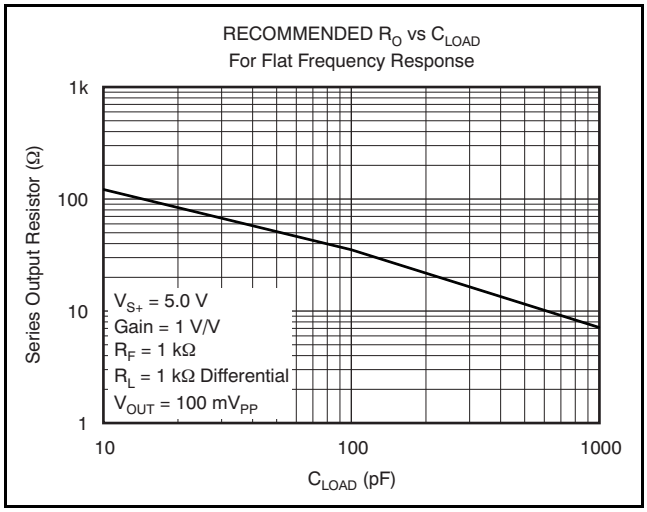


Figure 67. Recommended Series Output Resistor versus Capacitive Load for Flat Frequency Response, with R_{LOAD} = 1 kΩ

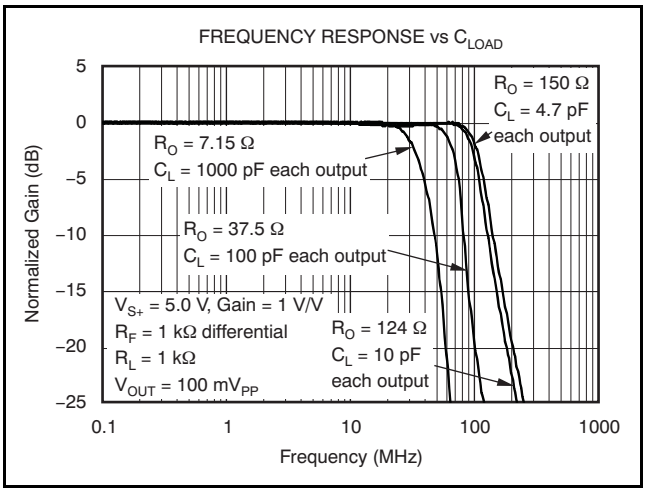


Figure 68. Frequency Response for Various R_O and C_L Values, with R_{LOAD} = 1 kΩ

Audio Performance

The THS4524 provides excellent audio performance with very low quiescent power. To show performance in the audio band, the device was tested with a SYS-2722 audio analyzer from Audio Precision. THD+N and FFT tests were performed at 1-V_{RMS} output voltage. Performance is the same on both 3.3-V and 5-V supplies. Figure 69 shows the test circuit used; see Figure 70 and Figure 71 for the performance of the analyzer using internal loopback mode (generator) together with the THS4524.

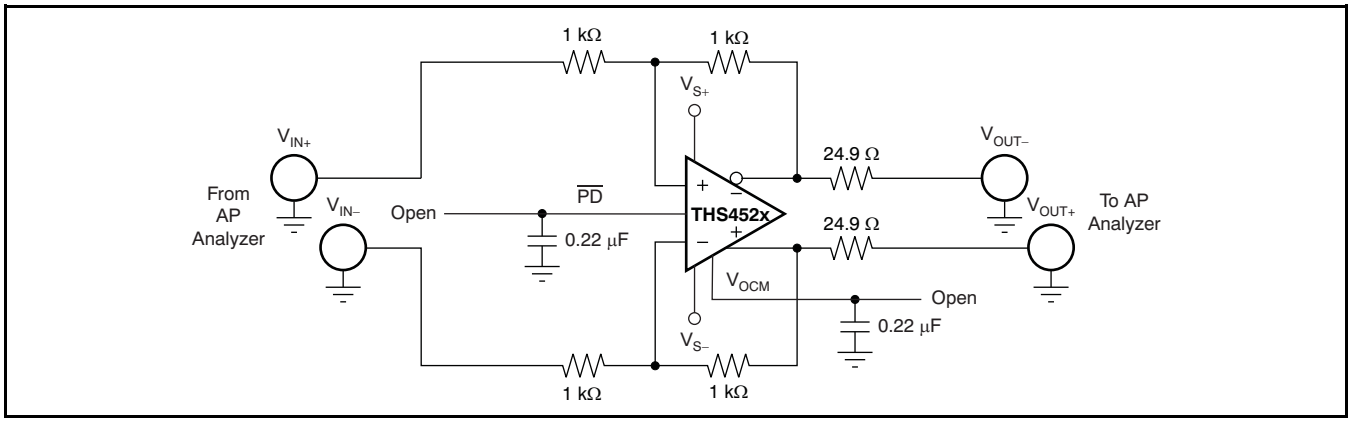


Figure 69. THS4524 AP Analyzer Test Circuit

Note that the harmonic distortion performance is very close to the same with and without the device meaning the THS4524 performance is actually much better than can be directly measured by this meathod. The actual device performance can be estimated by placing the device in a large noise gain and using the reduction in loop gain correction. The THS4524 is placed in a noise gain of 101 by adding a 10-Ω resistor directly across the input terminals of the circuit shown in Figure 69. This test was performed using the AP instrument as both the signal source and the analyzer. The second-order harmonic distortion at 1 kHz is estimated to be –122 dBc with V_O = 1V_{RMS}; third-order harmonic distortion is estimated to be –141 dBc. The third-order harmonic distortion result matches exactly with design simulations, but the second-order harmonic distortion is about 10 dB worse. This result is not unexpected because second-order harmonic distortion performance with a differential signal depends heavily on cancellation as a result of the differential nature of the signal, which depends on board layout, bypass capacitors, external cabling, and so forth. Note that the circuit of Figure 69 is also used to measure crosstalk between channels.

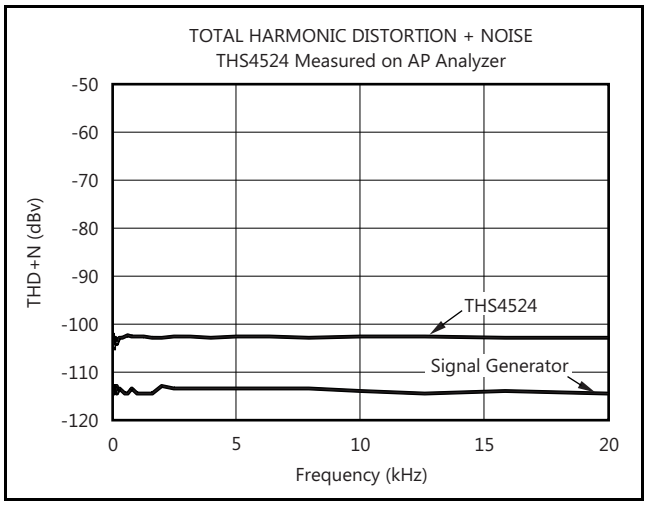


Figure 70. THS4524 1-V_{RMS} 20-Hz to 20-kHz THD+N

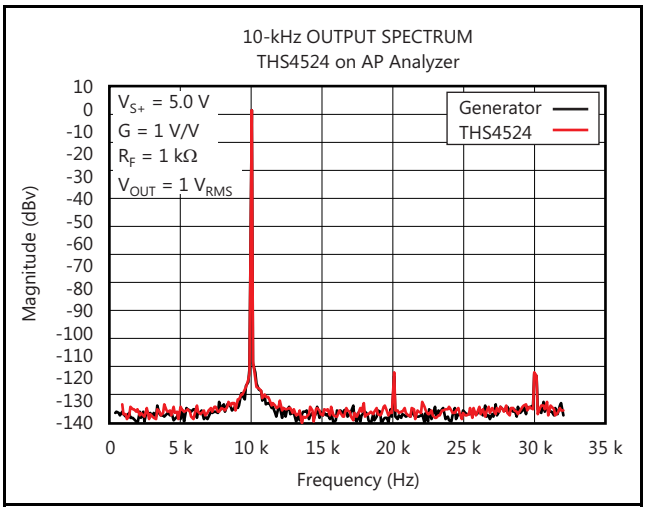


Figure 71. THS4524 1-V_{RMS} 10-kHz FFT Plot

The THS4524 shows even better THD+N performance when driving higher amplitude output, such as 5 V_{PP} that is more typical when driving an ADC. To show performance with an extended frequency range, higher gain, and higher amplitude, the device was tested with 5 V_{PP} up to 80 kHz with the AP. Figure 72 shows the resulting THD+N graph with no weighting.

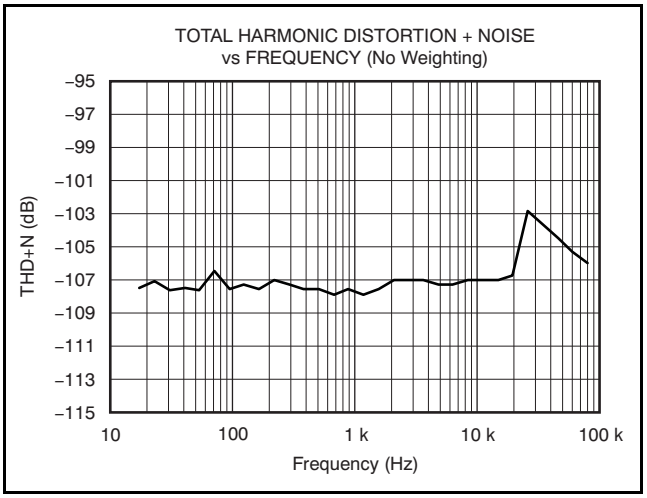


Figure 72. THD+N (No Weighting) on AP, 80-kHz Bandwidth at G = 1 with 5-V_{PP} Output

Audio On/Off Pop Performance

The THS4524 was tested to show on and off pop performance by connecting a speaker between the differential outputs and switching the power supply on and off, and also by using the $\overline{PD}$ function of the THS4524. Testing was done with and without tones. During these tests, no audible pop could be heard.

With no tone input, Figure 73 shows the pop performance when switching power on to the THS4524 and Figure 74 shows the device performance when turning the power off. The transients during power on and off illustrate that no audible pop should be heard

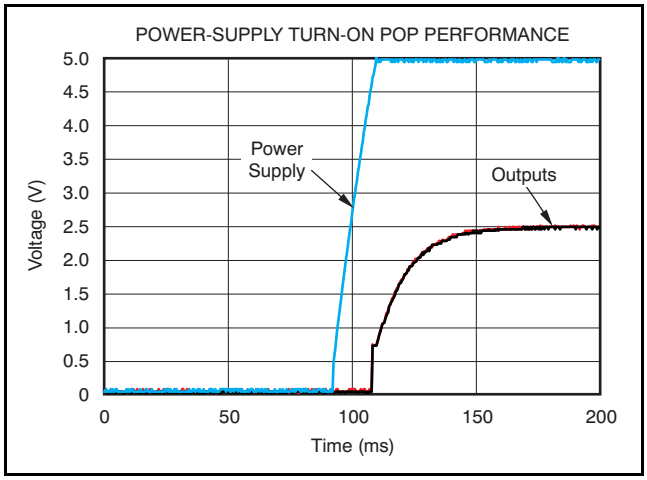


Figure 73. THS4524 Power-Supply Turn-On Pop Performance

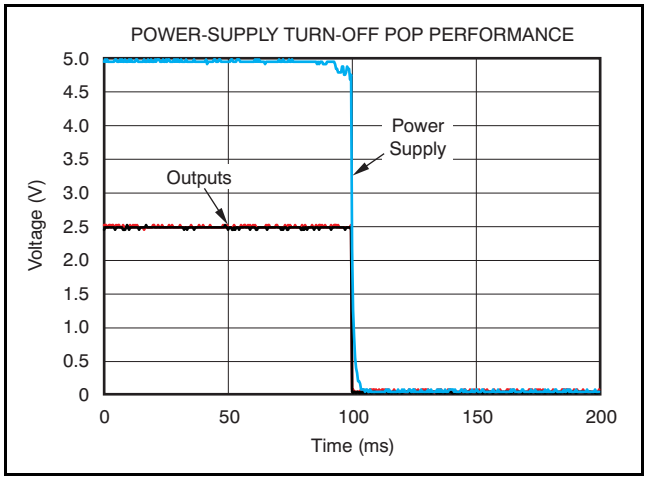


Figure 74. THS4524 Power-Supply Turn-Off Pop Performance

With no tone input, Figure 75 shows the pop performance using the $\overline{PD}$ pin to enable the THS4524, and Figure 76 shows performance using the $\overline{PD}$ pin to disable the device. Again, the transients during power on and off show that no audible pop should be heard. It should also be noted that the turn on/off times are faster using the $\overline{PD}$ pin technique.

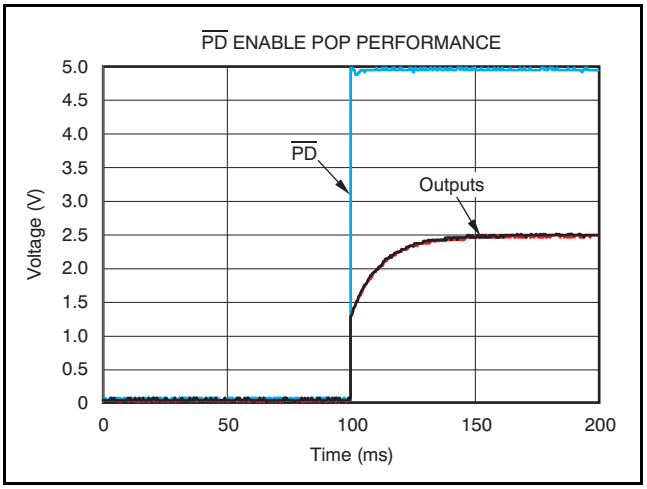


Figure 75. THS4524 $\overline{PD}$ Pin Enable Pop Performance

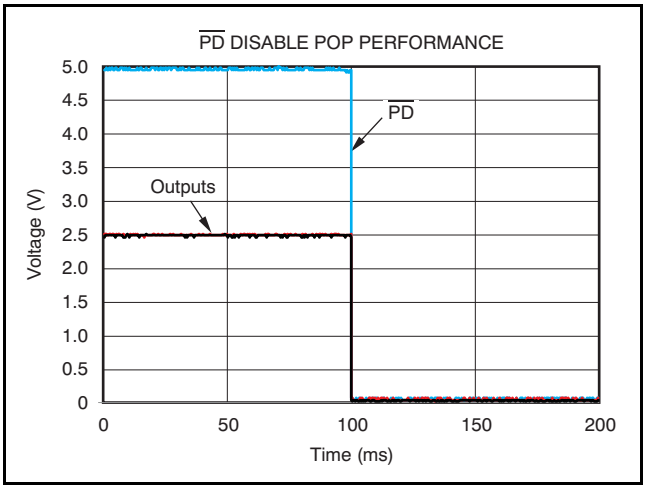


Figure 76. THS4524 $\overline{PD}$ Pin Disable Pop Performance

The power on/off pop performance of the THS4524, whether by switching the power supply or when using the power-down function built into the chip, shows that no special design should be required to prevent an audible pop.

Audio ADC Driver Performance: THS4524 and PCM4204 Combined Performance

To show achievable performance with a high-performance audio ADC, the THS4524 is tested as the drive amplifier for the PCM4204. The PCM4204 is a high-performance, four-channel ADC designed for professional and broadcast audio applications. The PCM4204 architecture uses a 1-bit delta-sigma (ΔΣ) modulator per channel that incorporates an advanced dither scheme for improved dynamic performance, and supports PCM output data. The PCM4204 provides a flexible serial port interface and many other advanced features. Refer to the PCM4204 product data sheet for more information.

The PCM4204EVM can test the audio performance of the THS4524 as a drive amplifier. The standard PCM4204EVM is provided with four OPA1632 fully-differential amplifiers, which use the same device pinout as the THS4524. For testing, one of these amplifiers is replaced with a THS4524 device in same package (MSOP), and the power supply changes to a single-supply +5V. Figure 79 shows the modifications made to the circuit. Note the resistor connecting the V_{OCM} input of the THS4524 to the input common-mode drive from the PCM4204 is shown removed and is optional; no performance change was noted with it connected or removed. The THS4524 is operated with a +5-V single-supply so the output common-mode defaults to +2.5 V as required at the input of the PCM4204. The EVM power connections were modified by connecting positive supply inputs, +15 V, +5 VA and +5 VD, to a +5-V external power supply (EXT +3.3 was not used) and connecting –15 V and all ground inputs to ground on the external power supply. Note only one external +5-V supply was needed to power all devices on the EVM.

A SYS-2722 Audio Analyzer from Audio Precision (AP) provides an analog audio input to the EVM; the PCM-formatted digital output is read by the digital input on the AP.

Data were taken using a 256-f_S system clock to achieve f_S = 48-kHz measurements, and audio output uses PCM format. Other data rates and formats are expected to show similar performance in line with that shown in the product data sheet.

Figure 77 shows the THD+N vs Frequency response with no weighting; Figure 78 shows an FFT of the output with 1-kHz input tone. Input signals to the PCM4204 for these tests is 0.5 dBFS. Dynamic range is also tested at –60 dBFS, f_{IN} = 1 kHz, and A-weighted. Table 4 summarizes testing results using the THS4524 together with the PCM4204 versus typical data sheet performance measurements, and show that it make an excellent drive amplifier for this ADC.

The test circuit shown in Figure 79 has a gain = 0.27 and attenuates the input signal. For applications that require higher gain, the circuit was modified to gains of G = 1, G = 2, and G = 5 by replacing the feedback resistors (R33 and R34) and re-tested to show performance.

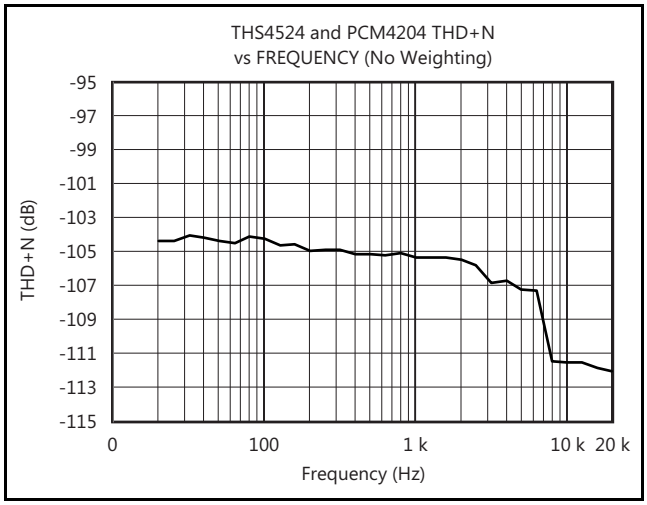


Figure 77. THS4524 and PCM4204: THD+N versus Frequency with No Weighting

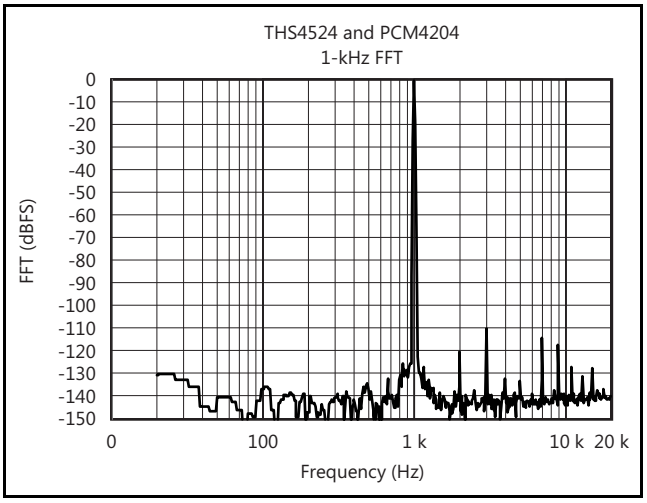


Figure 78. THS4524 and PCM4204 1-kHz FFT

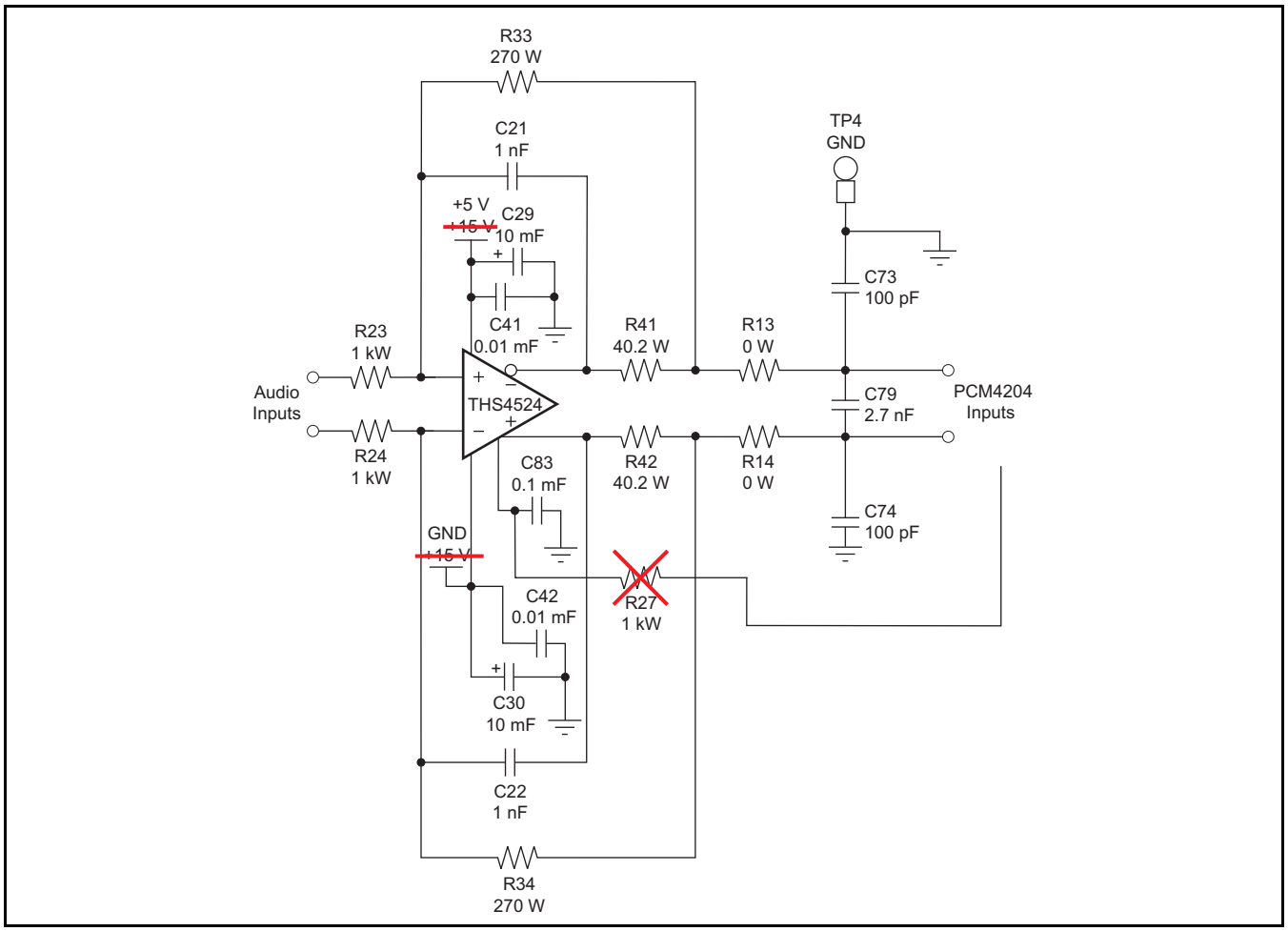


Figure 79. THS4524 and PCM4204 Test Circuit

Table 4. 1-kHz AC Analysis: Test Circuit versus PCM4204 Data Sheet Typical Specifications (f_S = 48 kSPS)

Configuration	Tone	THD+N	Dynamic Range
THS4524 and PCM4204	1 kHz	–106 dBc	117 dB
PCM4204 Data sheet (typ)	1 kHz	–105 dBc	118 dB

Figure 80 shows the THS4524 and PCM4204 THD+N versus frequency with no weighting at higher gains.

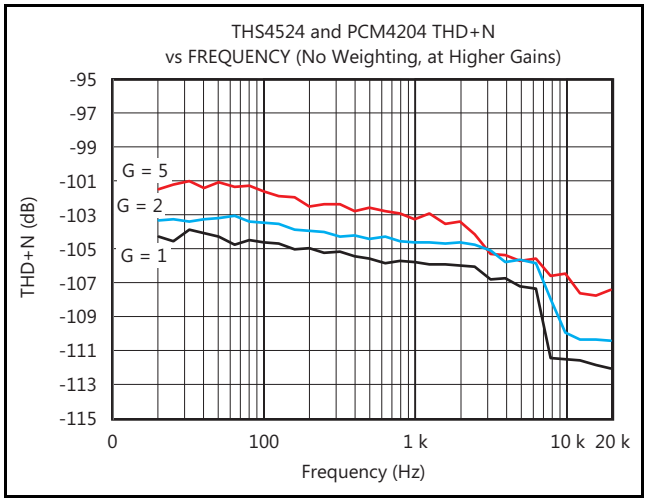


Figure 80. THS4524 and PCM4204: THD+N versus Frequency with No Weighting at Higher Gains

Audio ADC Driver Performance: THS4524 and PCM3168 Combined Performance

The THS4524 is also tested as the drive amplifier for the PCM3168A ADC input. The PCM3168A is a high-performance, single-chip, 24-bit, 6-in/8-out, audio coder/decoder (codec) with single-ended and differential selectable analog inputs and differential outputs. The six-channel, 24-bit ADC employs a ΔΣ modulator and supports 8-kHz to 96-kHz sampling rates and a 16-bit/24-bit width digital audio output word on the audio interface. The eight-channel, 24-bit digital-to-analog converter (DAC) employs a ΔΣ modulator and supports 8-kHz to 192-kHz sampling rates and a 16-bit/24-bit width digital audio input word on the audio interface. Each audio interface supports I^2S™, left-/right-justified, and DSP formats with 16-bit/24-bit word width. In addition, the PCM3168A supports the time-division-multiplexed (TDM) format.. The PCM3168A provides flexible serial port interface and many other advanced features. Refer to the PCM3168A product data sheet for more information.

The PCM3168A EVM is used to test the audio performance of the THS4524 as a drive amplifier. The standard PCM3168A EVM is provided with OPA2134 op amps that are used to convert single-ended inputs to differential to drive the ADC. For testing, the op amp output series resistors are removed from one of the channels and a THS4524, mounted on its standard EVM, is connected to the ADC inputs via short coaxial cables. The THS4524 EVM is configured for both differential inputs as shown in Figure 61 and for single-ended input as shown in Figure 62 with 1-kΩ resistors for R_F and R_G, and 24.9-Ω resistors in series with each output to isolate the outputs from the reactive load of the coaxial cables. To limit the noise from the external EVM and cables, a 2.7-nF capacitor is placed differentially across the PCM3168A inputs. The THS4524 is operated with a single-supply +5-V supply so the output common-mode of the THS4524 defaults to +2.5 V as required at the input of the PCM3168A. The PCM3168A EVM is configured and operated as described in the PCM3168AEVM User Guide. The ADC was tested with an external THS4524 EVM with both single-ended input and differential inputs. In both configurations, the results are the same. Figure 81 shows the THD+N versus frequency and Table 5 compares the result to the PCM3168 data sheet typical specification at 1 kHz. Both graphs show that it makes an excellent drive amplifier for this ADC. **Note:** a 2700 series Audio Analyzer from Audio Precision is used to generate the input signals to the THS4524 and to analyze the digital data from the PCM3168.

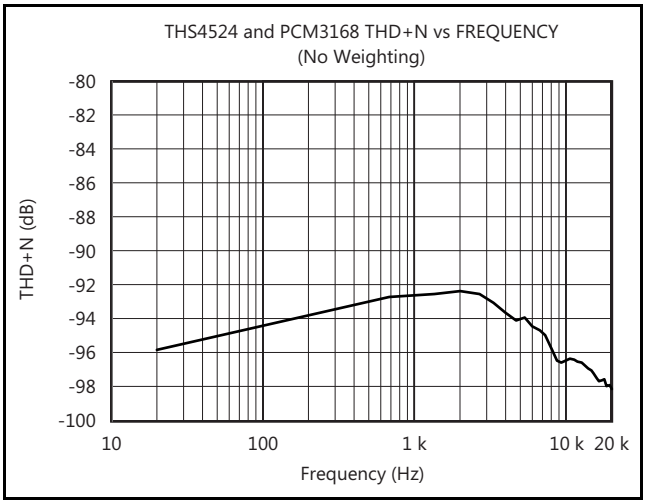


Figure 81. THS4524 and PCM3168: THD+N versus Frequency with No Weighting

Table 5. 1-kHz AC Analysis: Test Circuit vs PCM3168 Data Sheet Typical Specifications (f_S = 48 kSPS)

Configuration	Tone	THD+N
THS4524 and PCM3168	1 kHz	–92.6 dBc
PCM3168 Data sheet (typ)	1 kHz	–93 dBc

ADC Driver Performance: THS4524 and ADS1278 Combined Performance

The THS4524 provides excellent performance when driving high-performance ΔΣ and successive approximation register (SAR) ADCs in audio and industrial applications using a single 3-V to 5-V power supply. To show achievable performance, the THS4524 is tested as the drive amplifier for the ADS1278 24-bit ADC. The ADS1278 offers excellent ac and dc performance, with four selectable operating modes from 10 kSPS to 128 kSPS to enable the user to fine-tune performance and power for specific application needs. The circuit shown in Figure 82 was used to test the performance. Data were taken using the High-Resolution mode (52 kSPS) of the ADS1278 with input frequencies at 1 kHz and 10 kHz and signal levels 1/2 dB below full-scale (–0.5 dBFS). FFT plots showing the spectral performance are given in Figure 83 and Figure 84; tabulated ac analysis results are shown in Table 6 and compared to the ADS1278 data sheet typical performance specifications.

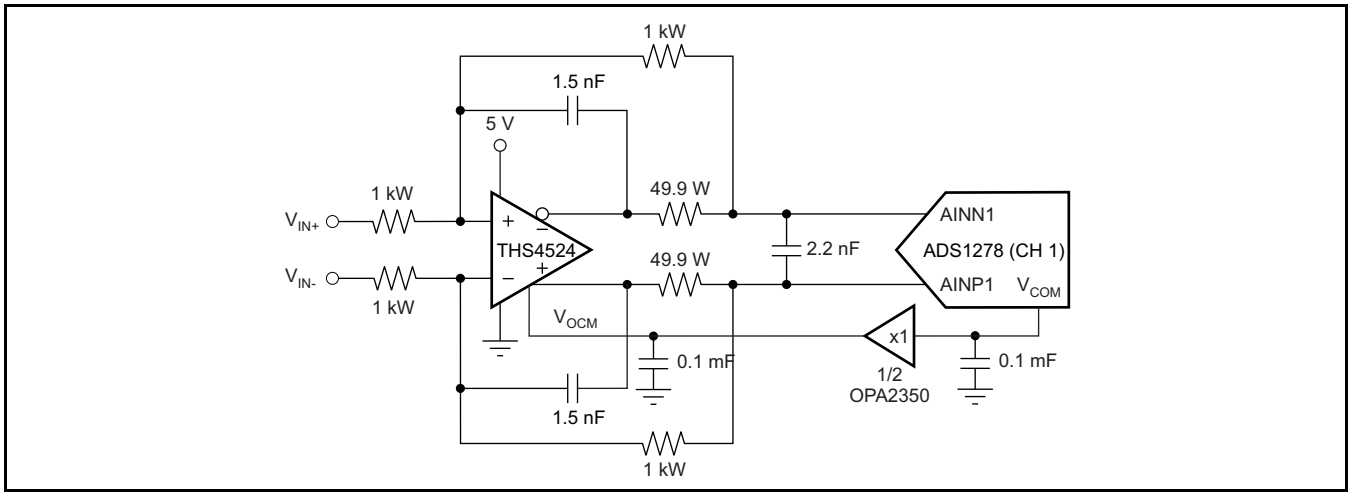


Figure 82. THS4524 and ADS1278 (Ch 1) Test Circuit

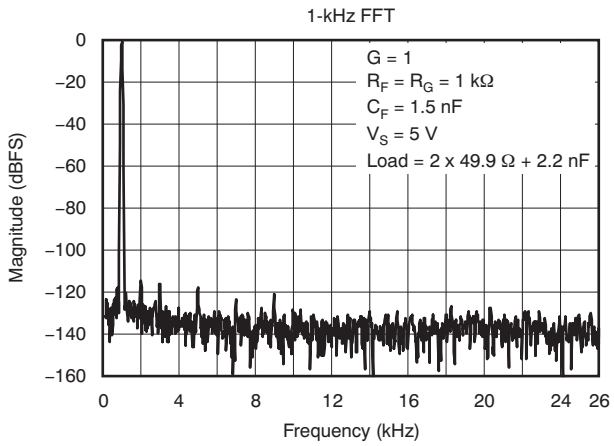


Figure 83. 1-kHz FFT

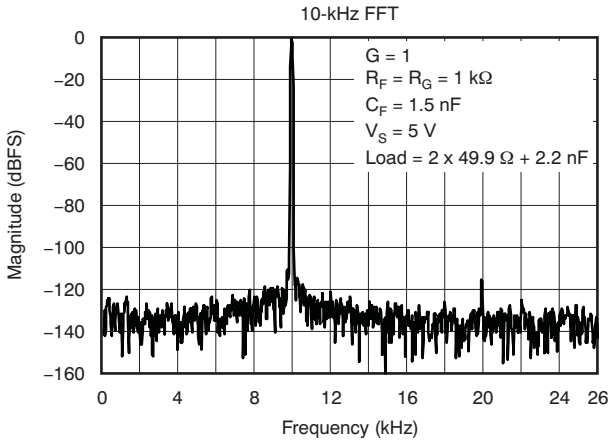


Figure 84. 10-kHz FFT

Table 6. AC Analysis

Configuration	Tone	Signal (dBFS)	SNR (dBc)	THD (dBc)	SINAD (dBc)	SFDR (dBc)
THS4524 and ADS1278	1 kHz	–0.5	109	–108	105	114
	10 kHz	–0.5	102	–110	101	110
ADS1278 Data sheet (typ)	1 kHz	–0.5	110	–108	—	109

ADC Driver Performance: THS4524 and ADS8321 Combined Performance

To demonstrate achievable performance, the THS4524 is tested as the drive amplifier for the ADS8321 16-bit SAR ADC. The ADS8321 offers excellent ac and dc performance, with ultra-low power and small size. The circuit shown in Figure 85 was used to test the performance.

Data were taken using the ADS8321 at 100 kSPS with input frequencies of 2 kHz and 10 kHz and signal levels that were -0.5 dBFS. FFT plots that illustrate the spectral performance are given in Figure 86 and Figure 87. Tabulated ac analysis results are listed in Table 7 and compared to the ADS8321 data sheet typical performance.

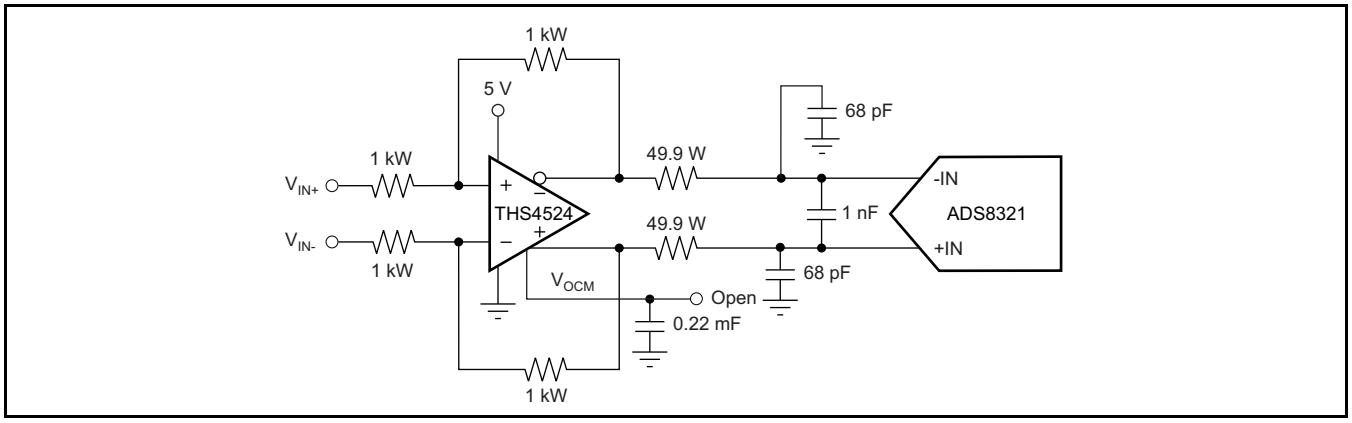


Figure 85. THS4524 and ADS8321 Test Circuit

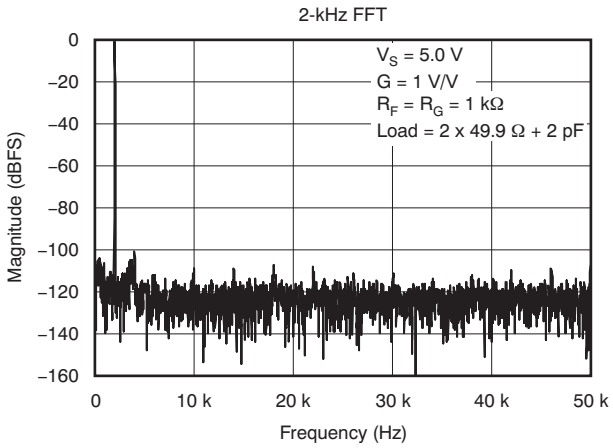


Figure 86. 2-kHZ FFT

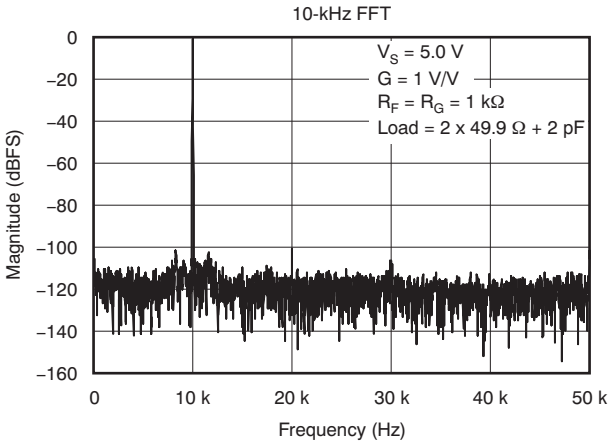


Figure 87. 10-kHz FFT

Table 7. AC Analysis

Configuration	Tone	Signal (dBFS)	SNR (dBc)	THD (dBc)	SINAD (dBc)	SFDR (dBc)
THS4524 and ADS8321	2 kHz	–0.5	86.7	–97.8	86.4	100.7
	10 kHz	–0.5	85.2	–98.1	85.2	102.2
ADS8321 Data sheet (typ)	10 kHz	–0.5	87	–86	84	86

EVM AND LAYOUT RECOMMENDATIONS

Figure 88 shows the THS4524EVM schematic. PCB layers 1 through 4 are shown in Figure 89; Table 8 lists the bill of materials for the THS4524EVM as supplied from TI. It is recommended to follow the layout of the external components near to the amplifier, ground plane construction, and power routing as closely as possible. Follow these general guidelines:

1. Signal routing should be direct and as short as possible into and out of the op amp circuit.
2. The feedback path should be short and direct.
3. Ground or power planes should be removed from directly under the amplifier input and output pins.
4. An output resistor is recommended in each output lead, placed as near to the output pins as possible.
5. Two 0.1-µF power-supply decoupling capacitors should be placed as near to the power-supply pins as possible.
6. Two 10-µF power-supply decoupling capacitors should be placed within 1 inch of the device and can be shared among multple analog devices.
7. A 0.22-µF capacitor should be placed between the V_{OCM} input pin and ground near to the pin. This capacitor limits noise coupled into the pin.
8. The $\overline{PD}$ pin uses TTL logic levels; a bypass capacitor is not necessary if actively driven, but can be used for robustness in noisy environments whether driven or not.
9. If input termination resistors R_{10} and R_{11} are used, a single point connection to ground on L2 is recommended.

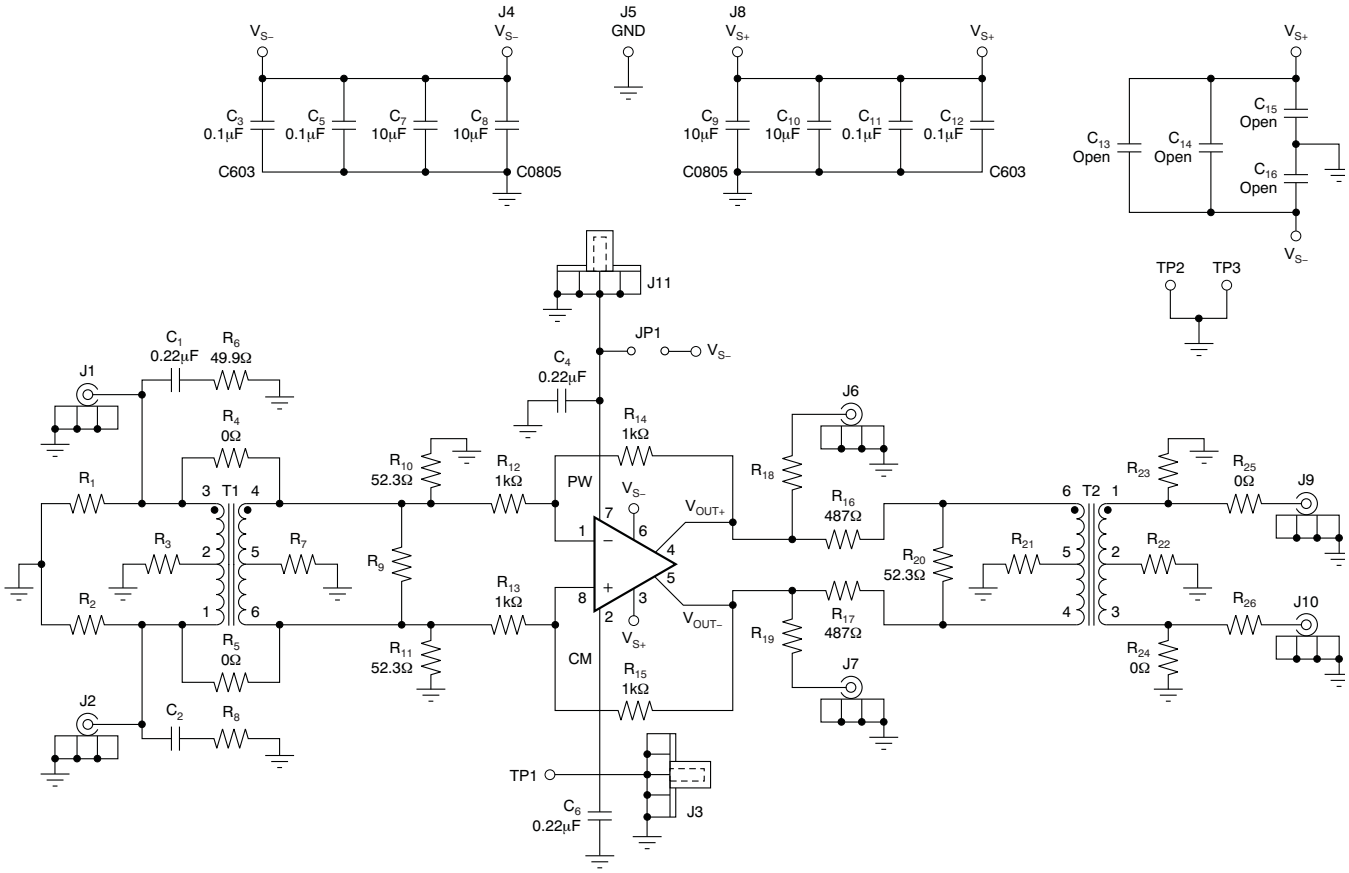


Figure 88. THS4524EVM: Schematic

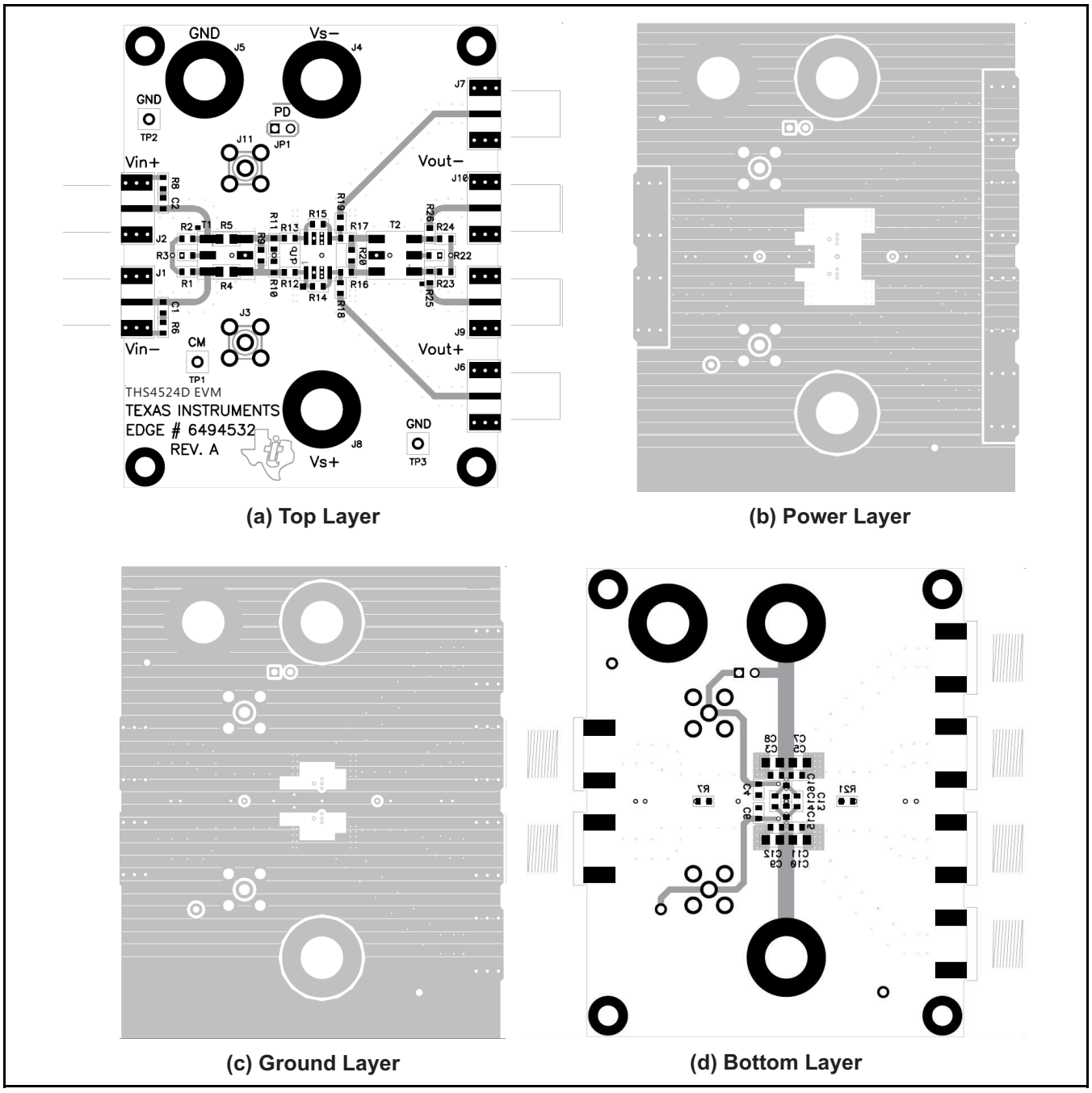


Figure 89. THS4524EVM: Layer 1 to Layer 4 Images

Table 8. THS4524EVM Parts List

ITEM	DESCRIPTION	SMD SIZE	REFERENCE DESIGNATOR	QTY	MANUFACTURER PART NUMBER
1	Capacitor, 10.0 µF, ceramic, X5R, 6.3 V	0805	C7, C8, C9, C10	4	(AVX) 08056D106KAT2A
2	Capacitor, 0.1 µF, ceramic, X7R, 16 V	0603	C3, C5, C11, C12	4	(AVX) 0603YC104KAT2A
3	Capacitor, 0.22 µF, ceramic, X7R, 10 V	0603	C1, C4, C6	3	(AVX) 0603ZC224KAT2A
4	Open	0603	C2, C13, C14, C15, C16	5	
5	Open	0603	R1, R2, R3, R7, R8, R9, R18, R19, R21, R22, R23, R26	12	
6	Resistor, 0 Ω	0603	R24, R25	2	(ROHM) MCR03EZPJ000
7	Resistor, 49.9 Ω, 1/10W, 1%	0603	R6	1	(ROHM) MCR03EZPFX49R9
8	Resistor, 52.3 Ω, 1/10W, 1%	0603	R10, R11, R20	3	(ROHM) MCR03EZPFX52R3
9	Resistor, 487 Ω, 1/10W, 1%	0603	R16, R17	2	(ROHM) MCR03EZPFX4870
10	Resistor, 1k Ω, 1/10W, 1%	0603	R12, R13, R14, R15	4	(ROHM) MCR03EZPFX1001
11	Resistor, 0 Ω	0805	R4, R5	2	(ROHM) MCR10EZPJ000
12	Open		T1	1	
13	Transformer, RF		T2	1	(MINI-CIRCUITS) ADT1-1WT
14	Jack, Banana receptance, 0.25-in dia. hole		J4, J5, J8	3	(SPC) 813
15	Open		J1, J3, J6, J7, J10, J11	6	
16	Connector, edge, SMA PCB jack		J2, J9	2	(JOHNSON) 142-0701-801
17	Header, 0.1 in CTRS, 0.025-in sq. pins	2 POS.	JP1	1	(SULLINS) PBC36SAAN
18	Shunts		JP1	1	(SULLINS) SSC02SYAN
19	Test point, Red		TP1	1	(KEYSTONE) 5000
20	Test point, Black		TP2, TP3	2	(KEYSTONE) 5001
21	IC, THS4524		U1	1	(TI) THS4524D
22	Standoff, 4-40 hex, 0.625 in length			4	(KEYSTONE) 1808
23	Screw, Phillips, 4-40, .250 in			4	SHR-0440-016-SN
24	Board, printed circuit			1	(TI) EDGE# 6494532

Evaluation Board/Kit Important Notice

Texas Instruments (TI) provides the enclosed product(s) under the following conditions:

This evaluation board/kit is intended for use for **ENGINEERING DEVELOPMENT, DEMONSTRATION, OR EVALUATION PURPOSES ONLY** and is not considered by TI to be a finished end-product fit for general consumer use. Persons handling the product(s) must have electronics training and observe good engineering practice standards. As such, the goods being provided are not intended to be complete in terms of required design-, marketing-, and/or manufacturing-related protective considerations, including product safety and environmental measures typically found in end products that incorporate such semiconductor components or circuit boards. This evaluation board/kit does not fall within the scope of the European Union directives regarding electromagnetic compatibility, restricted substances (RoHS), recycling (WEEE), FCC, CE or UL, and therefore may not meet the technical requirements of these directives or other related directives.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE.

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods. Due to the open construction of the product, it is the user's responsibility to take any and all appropriate precautions with regard to electrostatic discharge.

EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

TI currently deals with a variety of customers for products, and therefore our arrangement with the user **is not exclusive.**

TI assumes **no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein.**

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please contact the TI application engineer or visit www.ti.com/esh.

No license is granted under any patent right or other intellectual property right of TI covering or relating to any machine, process, or combination in which such TI products or services might be or are used.

FCC Warning

This evaluation board/kit is intended for use for **ENGINEERING DEVELOPMENT, DEMONSTRATION, OR EVALUATION PURPOSES ONLY** and is not considered by TI to be a finished end-product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC rules, which are designed to provide reasonable protection against radio frequency interference. Operation of this equipment in other environments may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

EVM Warnings and Restrictions

It is important to operate this EVM within the input voltage range of 3 V to 5.5 V and the output voltage range of 3 V to 5.5 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 125°C. The EVM is designed to operate properly with certain components above 125°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
THS4524MDBTREP	Active	Production	TSSOP (DBT) | 38	2000 | LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-55 to 125	THS4524EP
V62/12612-01XE	Active	Production	TSSOP (DBT) | 38	2000 | LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-55 to 125	THS4524EP

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

OTHER QUALIFIED VERSIONS OF THS4524-EP :

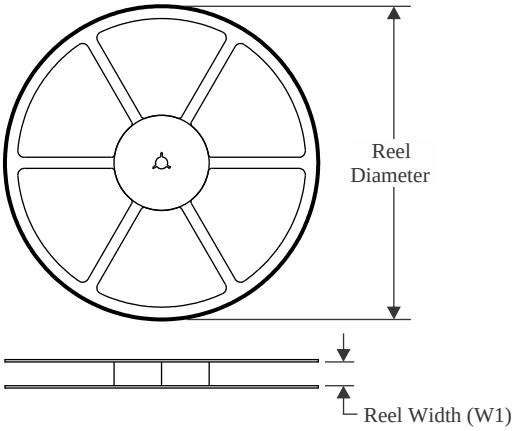
- Catalog : THS4524

NOTE: Qualified Version Definitions:

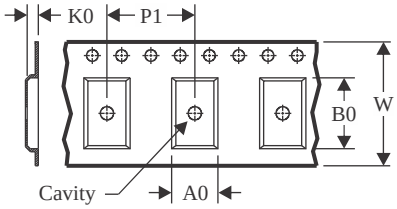
- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION

REEL DIMENSIONS

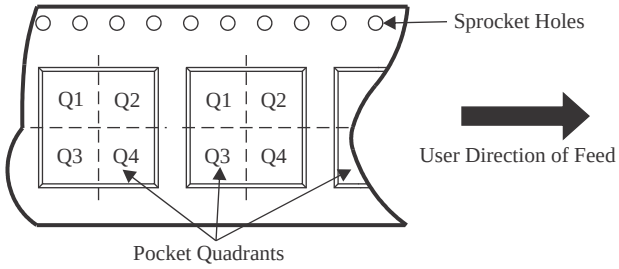


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

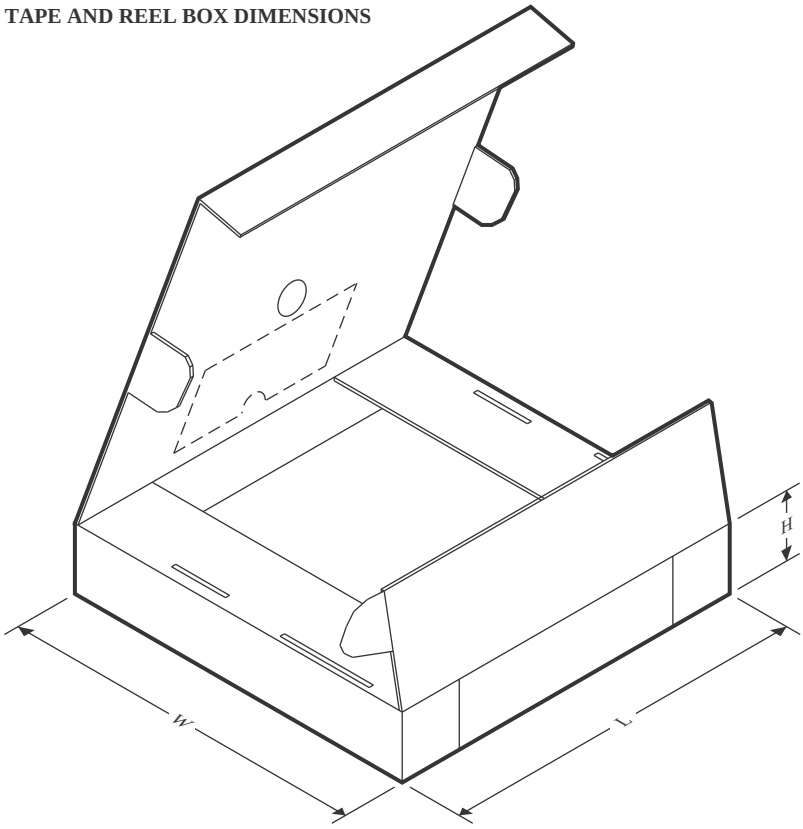
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
THS4524MDBTREP	TSSOP	DBT	38	2000	330.0	16.4	6.75	10.1	1.8	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

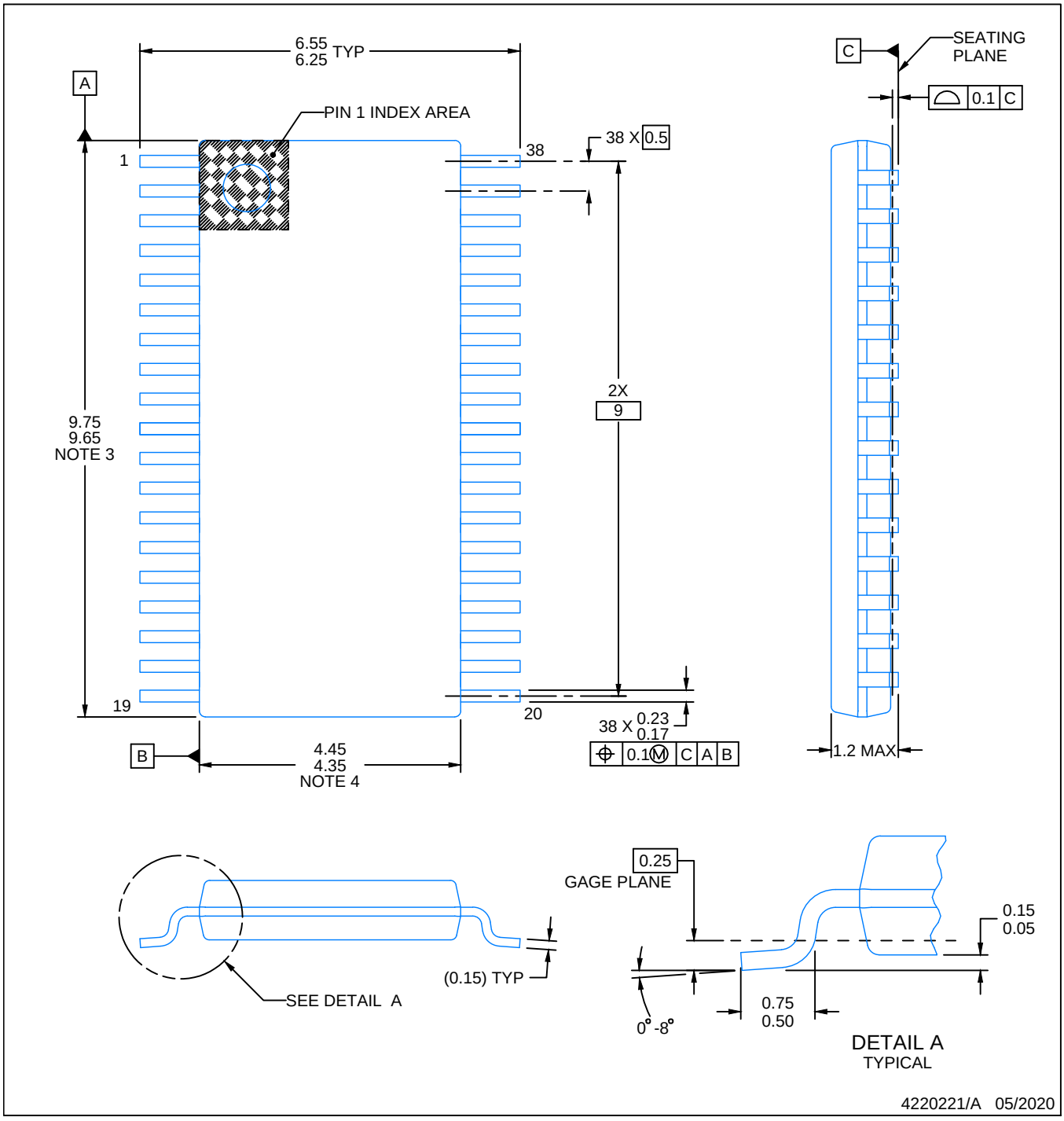
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
THS4524MDBTREP	TSSOP	DBT	38	2000	353.0	353.0	32.0

PACKAGE OUTLINE

DBT0038A

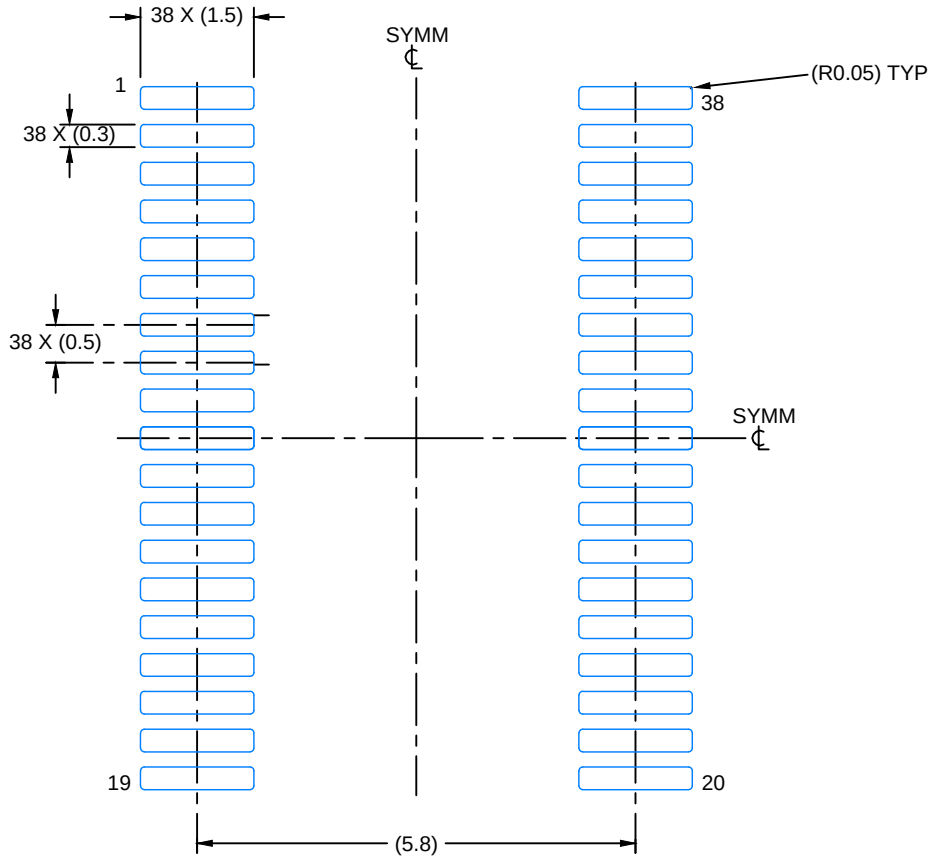
TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE

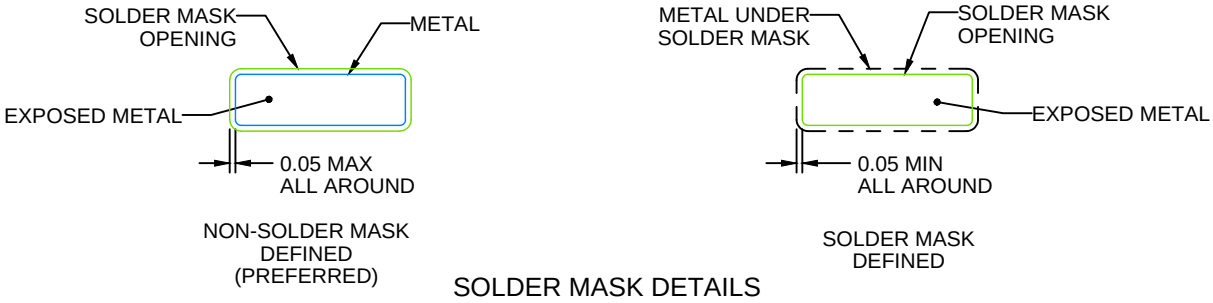


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X

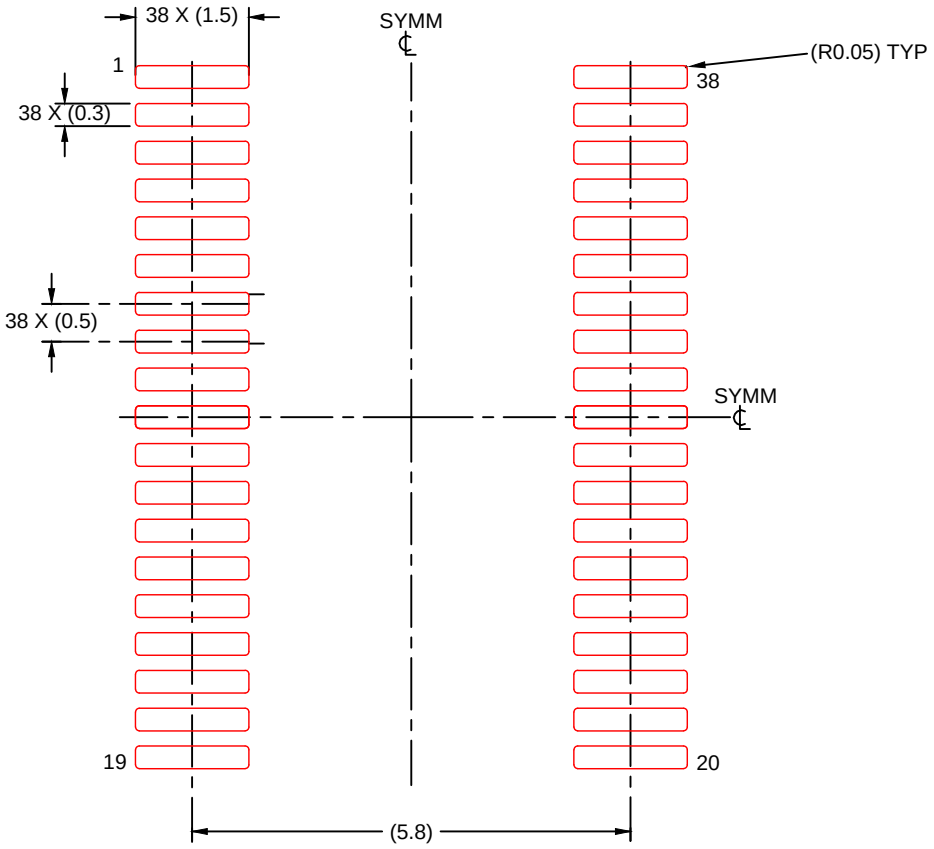


SOLDER MASK DETAILS

4220221/A 05/2020

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

4220221/A 05/2020

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

重要通知和免责声明

TI“按原样”提供技术和可靠性数据（包括数据表）、设计资源（包括参考设计）、应用或其他设计建议、网络工具、安全信息和其他资源，不保证没有瑕疵且不做出任何明示或暗示的担保，包括但不限于对适销性、与某特定用途的适用性或不侵犯任何第三方知识产权的暗示担保。

这些资源可供使用 TI 产品进行设计的熟练开发人员使用。您将自行承担以下全部责任：(1) 针对您的应用选择合适的 TI 产品，(2) 设计、验证并测试您的应用，(3) 确保您的应用满足相应标准以及任何其他安全、安保法规或其他要求。

这些资源如有变更，恕不另行通知。TI 授权您仅可将这些资源用于研发本资源所述的 TI 产品的相关应用。严禁以其他方式对这些资源进行复制或展示。您无权使用任何其他 TI 知识产权或任何第三方知识产权。对于因您对这些资源的使用而对 TI 及其代表造成的任何索赔、损害、成本、损失和债务，您将全额赔偿，TI 对此概不负责。

TI 提供的产品受 TI 销售条款)、TI 通用质量指南 或 ti.com 上其他适用条款或 TI 产品随附的其他适用条款的约束。TI 提供这些资源并不会扩展或以其他方式更改 TI 针对 TI 产品发布的适用的担保或担保免责声明。 除非德州仪器 (TI) 明确将某产品指定为定制产品或客户特定产品，否则其产品均为按确定价格收入目录的标准通用器件。

TI 反对并拒绝您可能提出的任何其他或不同的条款。

最后更新日期：2025 年 10 月